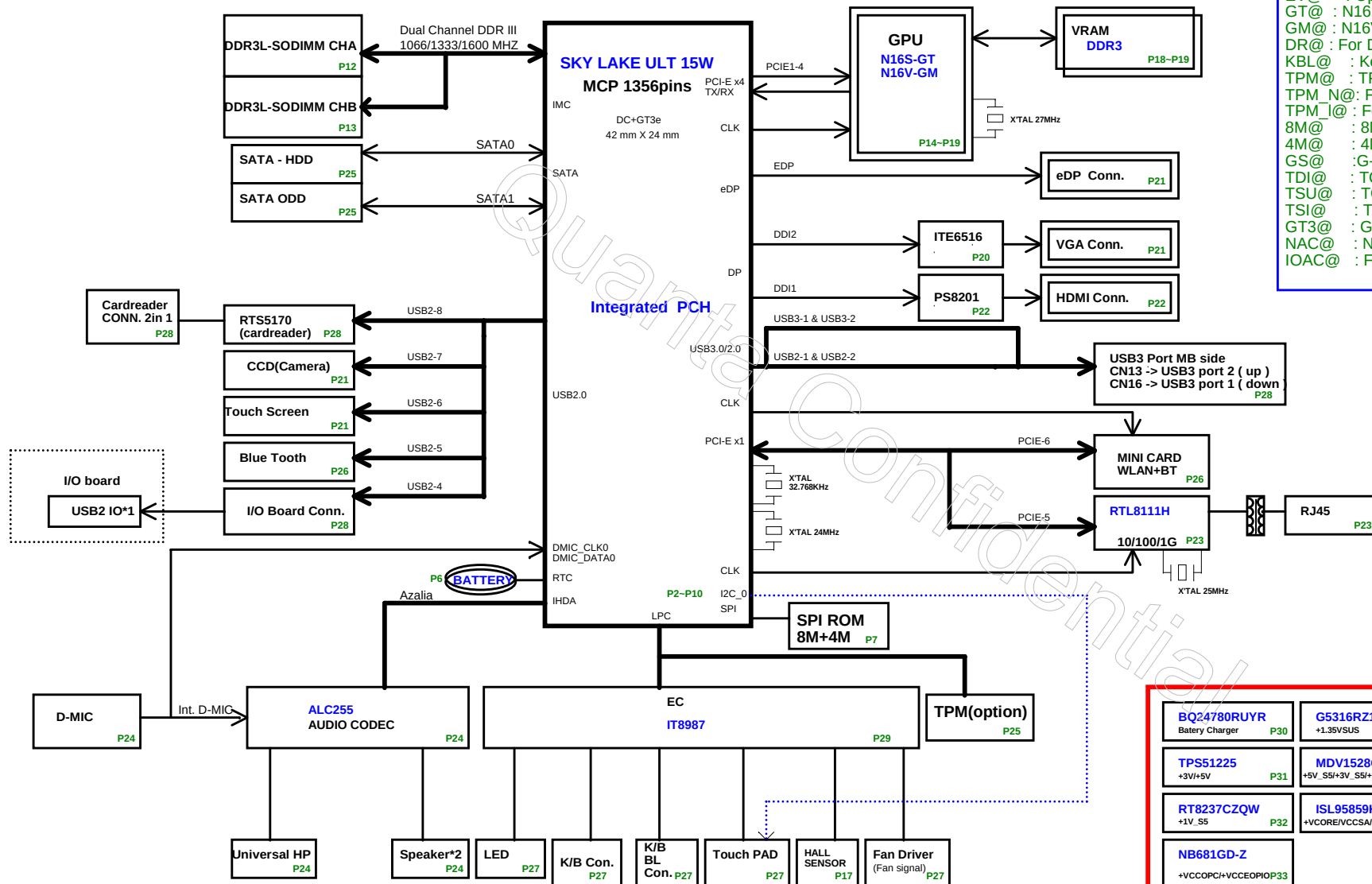


Zoro SL (ZRW) SKL ULT SYSTEM BLOCK DIAGRAM

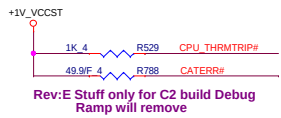
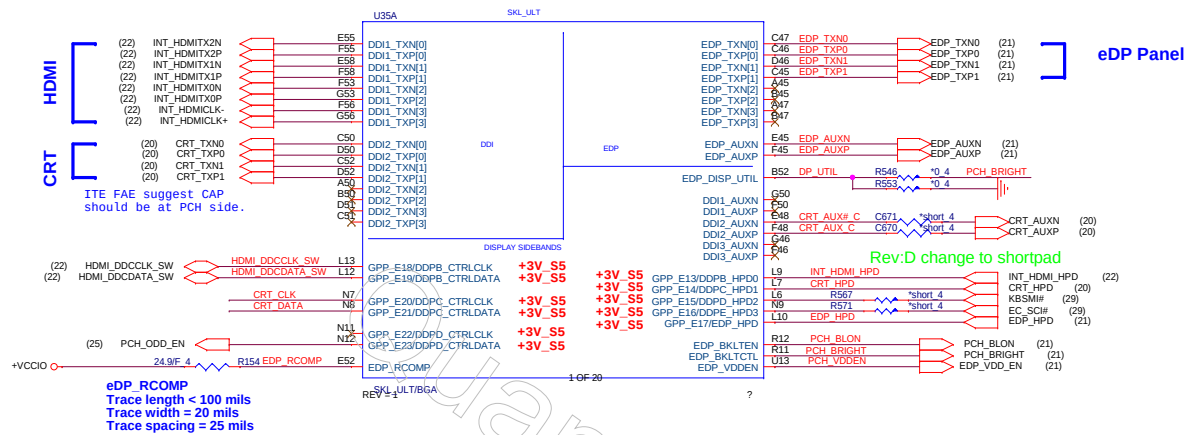


BOM

IV@ : iGPU
 EV@ : Optimus
 GT@ : N16S-GT / GC6
 GM@ : N16V-GM / WO GC6
 DR@ : For Dual Rank (VRAM 8 pcs)
 KBL@ : Keyboard backlight
 TPM@ : TPM
 TPM_N@ : For TPM 2.0
 TPM_I@ : For TPM 1.2
 8M@ : 8M FLASH ROM
 4M@ : 4M FLASH ROM
 GS@ : G-SENSOR
 TDI@ : TOUCH PAD I2C
 TSU@ : TOUCH SCREEN USB
 TSI@ : TOUCH SCREEN I2C
 GT3@ : GT3 CPU
 NAC@ : Non IOAC
 IOAC@ : For IOAC

BQ24780RUYR Battery Charger P30	G5316RZ1D +1.35VSUS P35	Thermal Protection Discharger P40
TPS51225 +3V/+5V P31	MDV1528Q +5V_S5/+3V_S5/+3V/+5V P31	UP1658RQKF +VGPU CORE P41
RT8237CZQW +1V_S5 P32	ISL95859HRTZ-T +VCCOE/VCCSA/VCCGT P38	RT8068AZQW +1.05V_GFX/+3V_GFX +1.5V_GFX P42
NB681GD-Z +VCCOPCI/+VCCOPROP33		

Skylake ULT (DISPLAY,eDP)

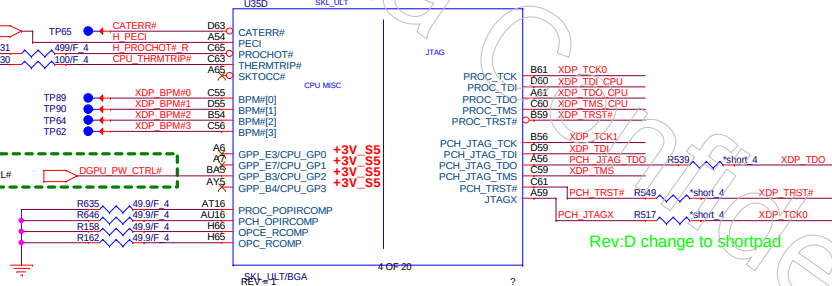


H_PECI (50ohm)
Route on microstrip only
Spacing >18 mils
Trace Length: 0.4~6.125 inches



BPM#[0:7]
Trace Length 1~6 inches
Length match < 300 mils

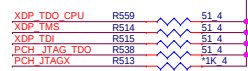
SM_RCOMP[0:2]
Trace length < 500 mils
Trace width = 12~15 mils
Trace spacing = 20 mils



PCH JTAG
JTAG_TCK,JTAG_TMS
Trace Length < 9000mils

TCK,TMS
Trace Length < 9000mils

MP remove(Intel)
Change to +1V_VCCST 11/6

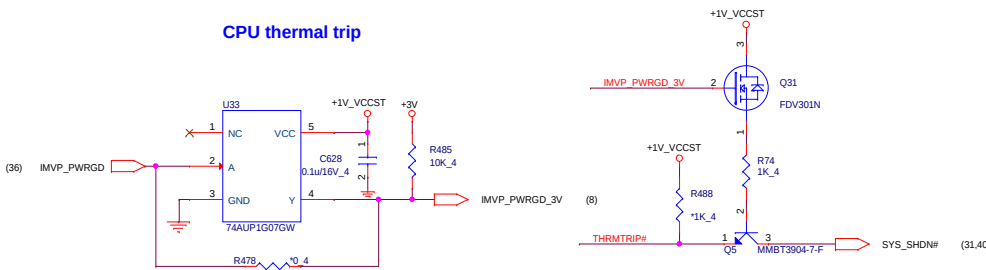


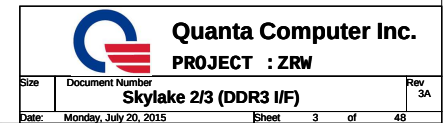
2/16
XDP_TCK1,XDP_TMS
don't need pull up or pull down
5/29 XDP_TCK0 R558 Stuff

If use Intel DCI USB 3.0 fixture need to short
1. XDP_TDO <-> XDP_TDO_CPU
2. XDP_TDI <-> XDP_TDI_CPU
3. XDP_TMS <-> XDP_TMS_CPU

H_PWRGOOD (50ohm)
Trace Length: 1~11.25 inches

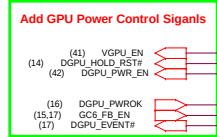
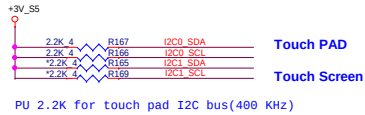
CPU thermal trip



SKL ULT (DDR3L)

H. PECCI (50ohm)
Route on microstrip only
Spacing >18 mils
Trace Length: 0.4-6.125 inches

H. PWGOOD (50ohm)
Trace Length: 1-11.25 inches



UART2 for RMT

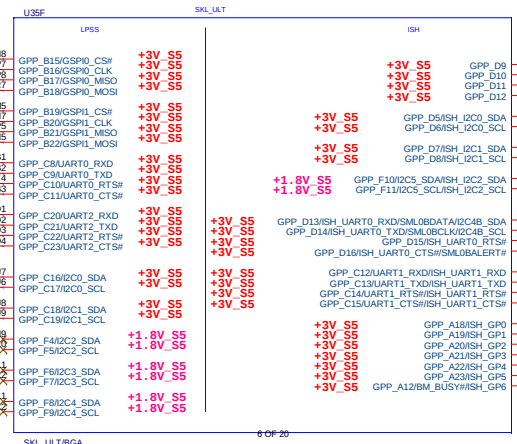
Touch PAD

Touch Screen

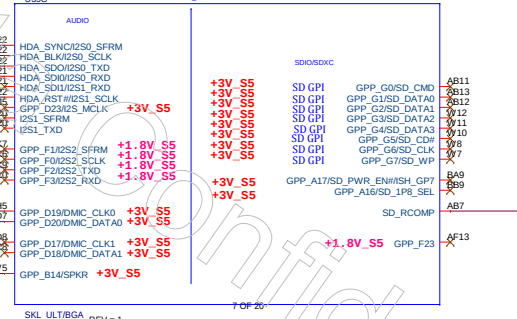
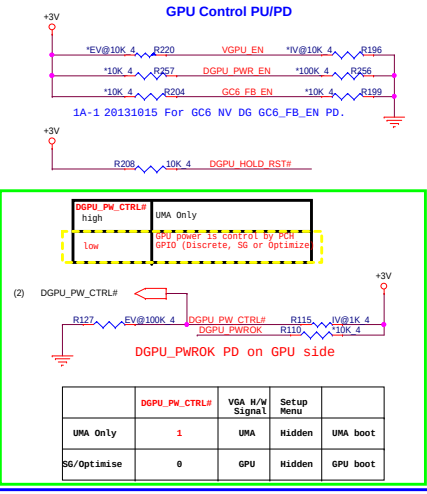
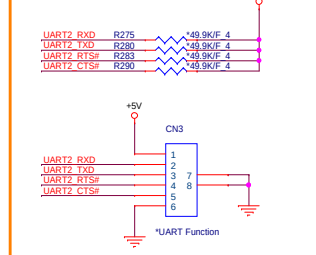
HDA

Reserve connect to DMIC (acer request 1/14)

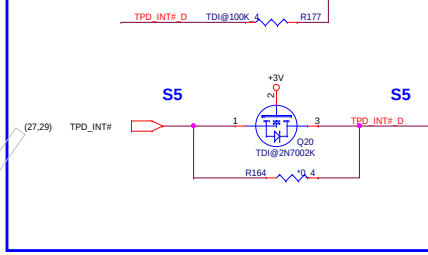
Strapping



Reserve UART FFC connector for Win 7 debug



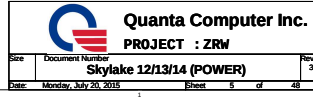
Touchpad INT



Skylake-U Strapping Table

Pin Name	Strap description	Sampled	Configuration	note
GPP_B14 (SPKR)	Top-Block Swap override	PCH_PWROK	0 = *Disable Top Swap (IPD 20K) 1 = Enable Top Swap Mode	+3V
GPP_B18 (GSP10_MOSI)	No reboot	PCH_PWROK	0 = *Disable No Reboot (IPD 20K) 1 = Enable No Reboot Mode	+3V
GPP_C2 (SMBALERT#)	TLS Confidentiality	RSMRST#	0 = *Disable Intel ME Crypt to TLS(IPD 20K) 1 = Enable Intel ME Crypt to TLS	+3V_S5
GPP_B22 (GSP11_MOSI)	Boot BIOS Strap Bit (BBS)	PCH_PWROK	0 = *SPI (IPD 20K) 1 = LPC	+3V
GPP_C5 (SML0ALERT#)	eSPI or LPC	RSMRST#	0 = *LPC is selected for EC (IPD 20K) 1 = eSPI selected for EC	+3V_S5
SPI0_MOSI	Reserved	RSMRST#	(IPU 15 ~ 40K)	
SPI0_MISO	Reserved	RSMRST#	(IPU 15 ~ 40K)	
GPP_B23 (SML1ALERT# /PCHHOT#)	Reserved	RSMRST#	(IPD 20K)	
SPI0_IO2	Reserved	RSMRST#	(IPU 15 ~ 40K)	
SPI0_IO3	Reserved	RSMRST#	(IPU 15 ~ 40K)	
HDA_SDO / I2S_TXD0	Flash Descriptor Security Override / Intel ME Debug Mode	PCH_PWROK	0 = *Enable security in the Flash Description (IPD 20K) 1 = Disable Flash Descriptor Security (Override)	change location to near CPU to prevent impact HDA_SDO signal
GPP_E19 (DDPB_CTRLDATA)	Display Port B Detected	PCH_PWROK	0 = *Port B is not detected (IPD 20K) 1 = Port B is detected	
GPP_E21 (DDPC_CTRLDATA)	Display Port C Detected	PCH_PWROK	0 = *Port C is not detected (IPD 20K) 1 = Port C is detected	

05



dGPU PEG4

LAN

WIFI

HDD

ODD

NI&S VGA

LAN

WLAN

Rev:D change to shortpad

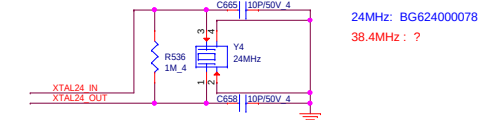
Rev:D add for EC reset RTC

1V power plane
0.71 checklist p14

USBCOMP
Impedance = 50 ohm
Trace length < 500 mils
Trace spacing = 15 mils

MB U3
MB U3
DB U3

Skylake-U used 24 MHz (50 Ohm ESR) XTAL

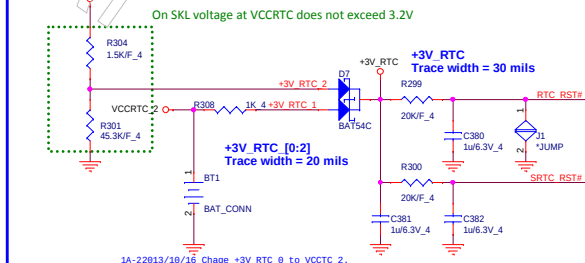


Note: Change Y4 to 38.4 MHz(ESR 30 ohm) for Cannonlake U

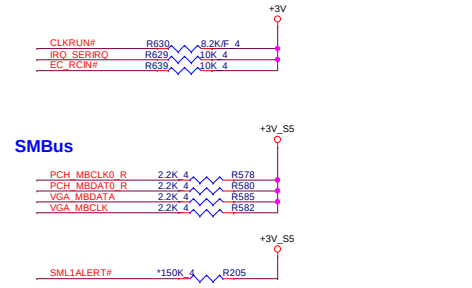
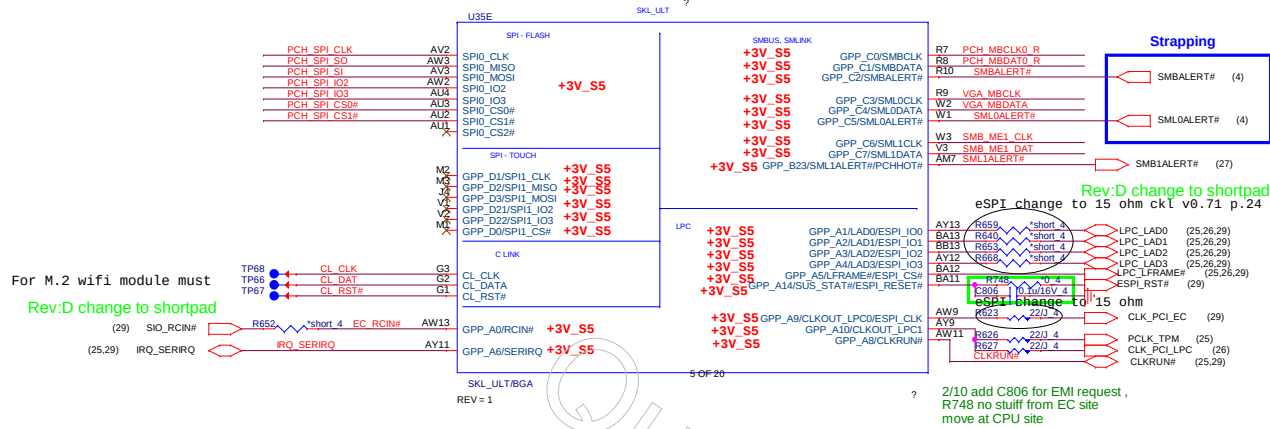
RTC Clock 32.768KHz (RTC)

Trace length < 1000 mils

RTC Circuitry (RTC)



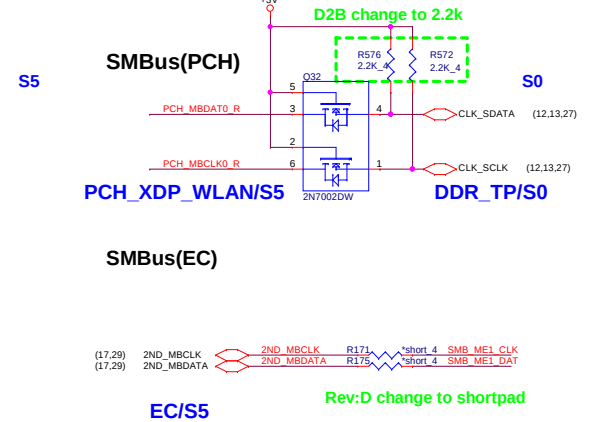
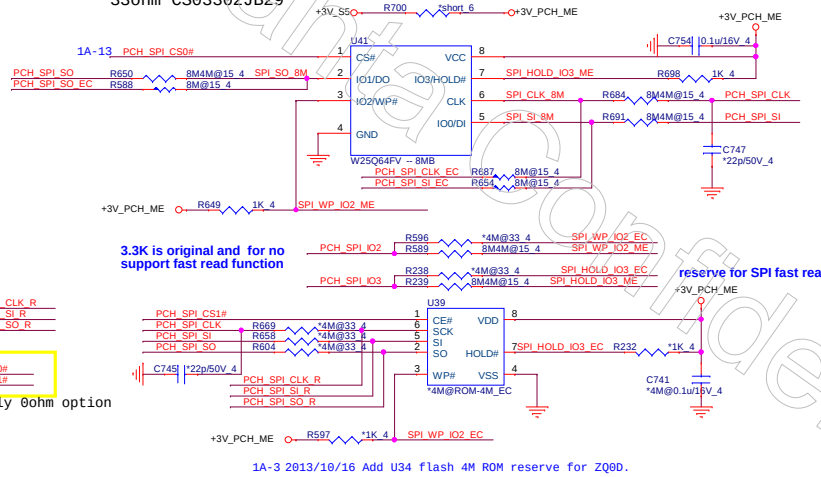
1. AHL03003057 DBV CR2032
2. AHL03003003 VDE CR2032

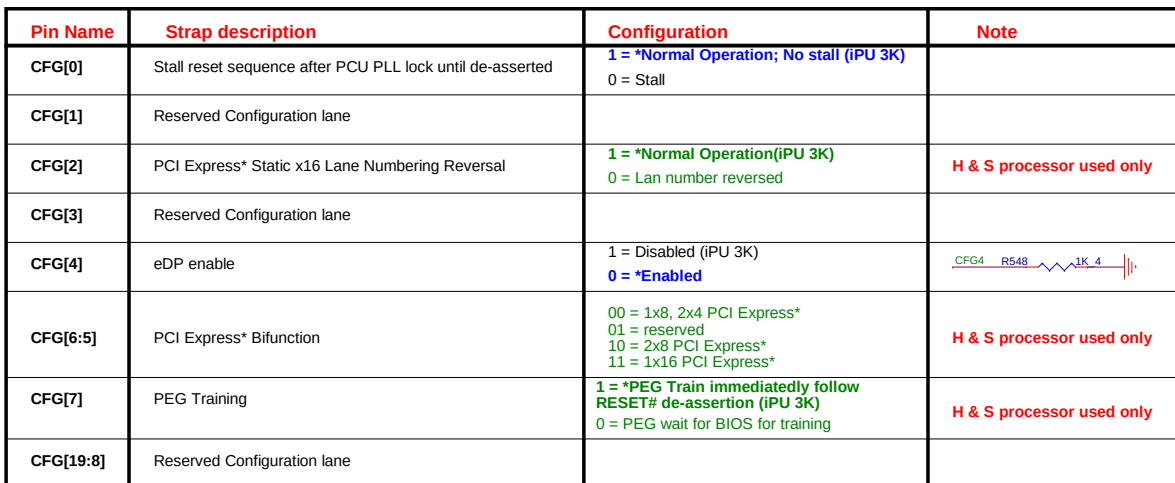


SPI ROM	Vender	Size	Quanta P/N	Vender P/N
Skylake 3.3V	WND	8M	AKE3EFP0N07	W25Q64FVSSIQ
	GGD	8M	AKE2EZNOQ00	GD25B64CSIGR

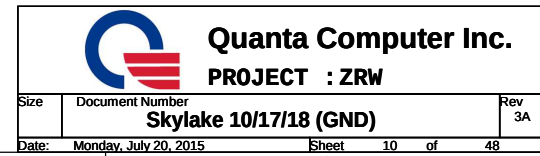
PCH SPI ROM(8M+4M)
15ohm CS01502JB12
33ohm CS03302JB29

Rev:D change to shortpad

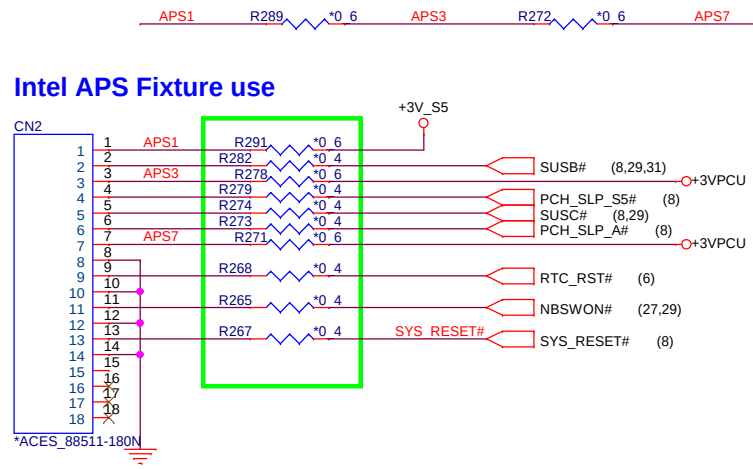


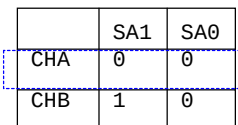


	D
	C
	B
	A

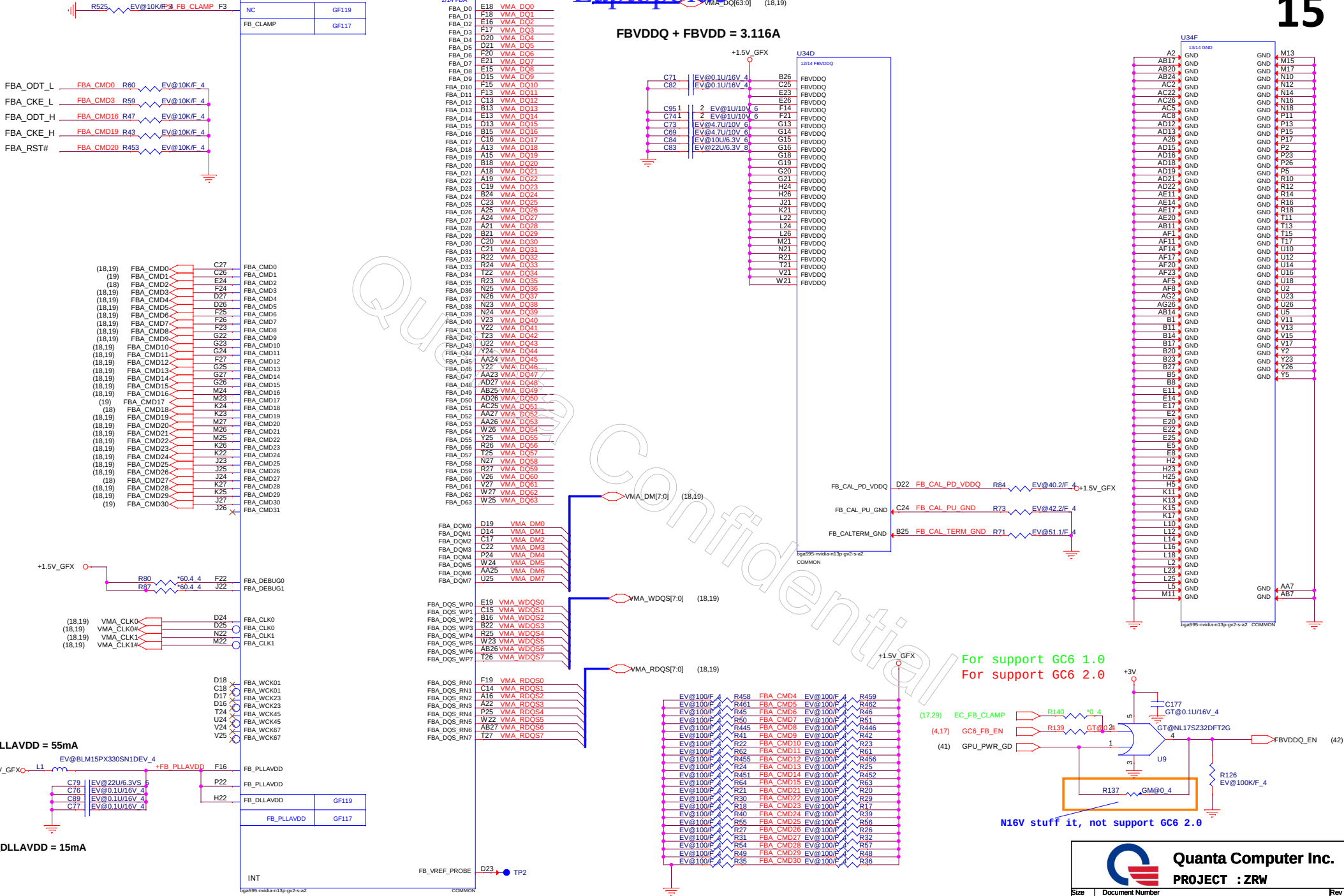


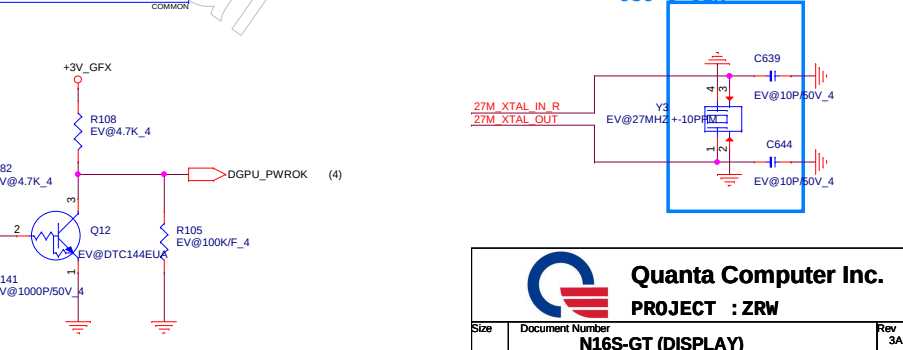
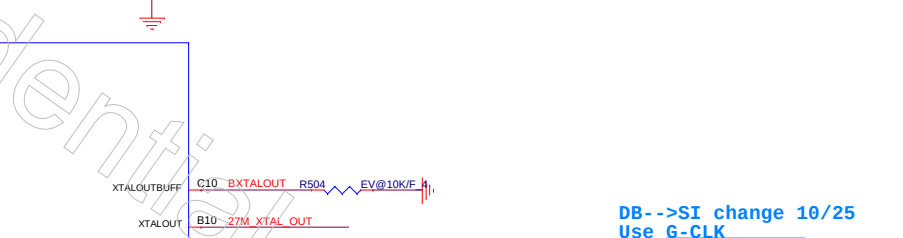
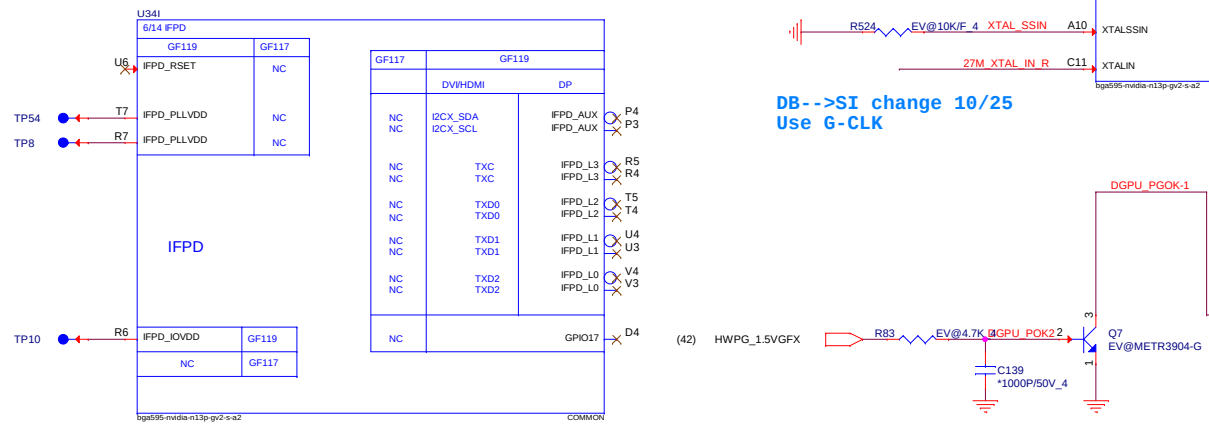
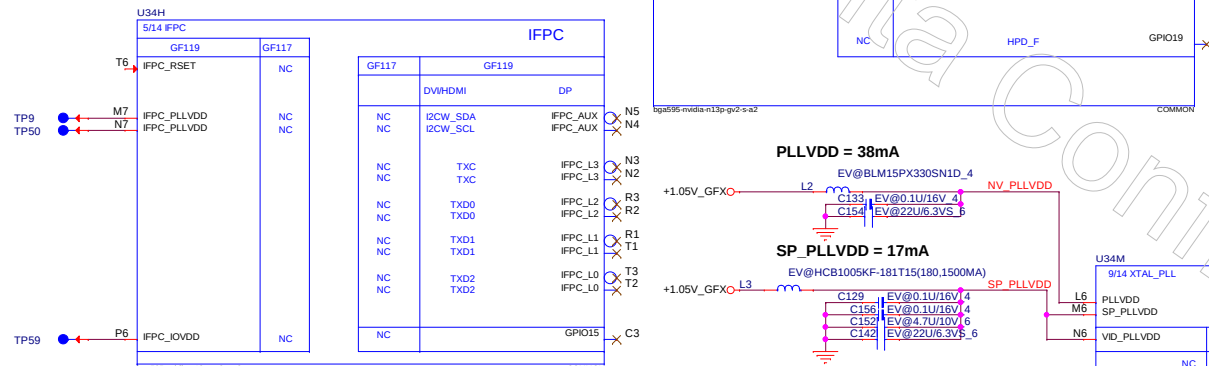
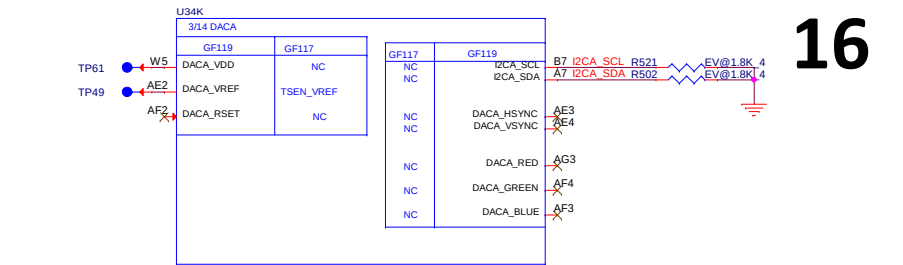
Quanta Confidential

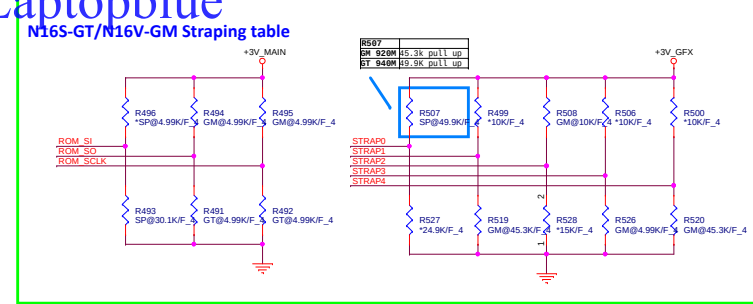
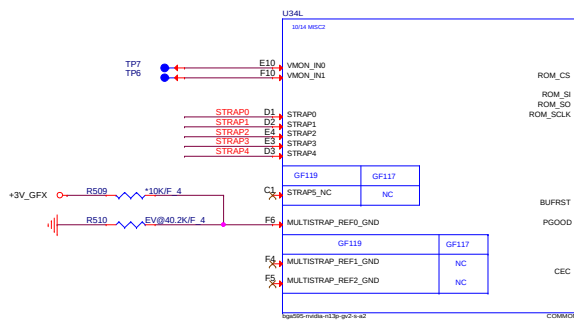




FBVDDQ + FBVDD = 3.116A







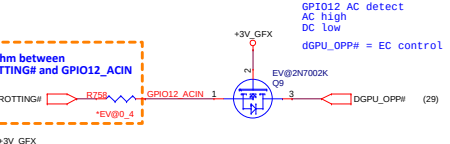
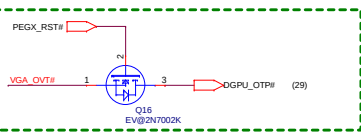
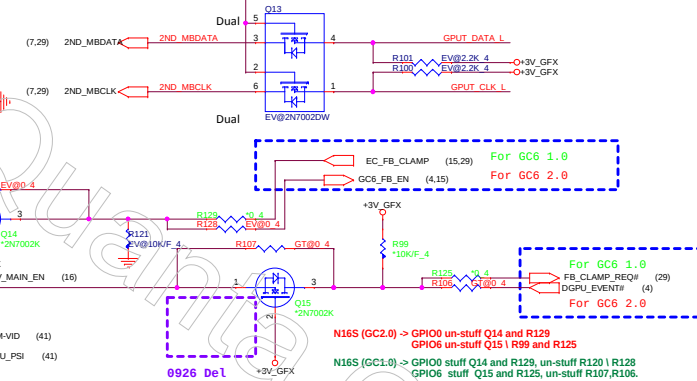
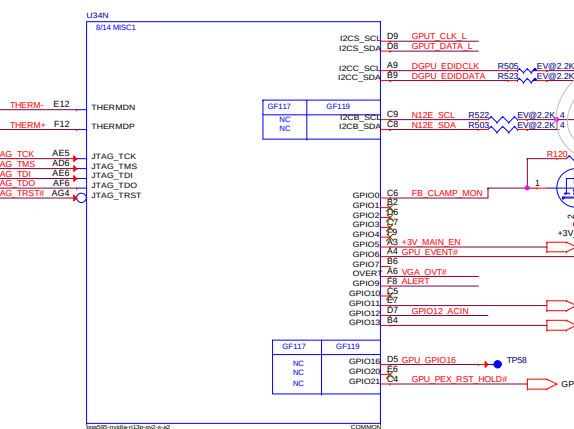
N16S-GT DID=0x1347 [940M]

ROM_SCLK = Stuff 4.99k pull down
ROM_SO = Stuff 4.99k pull down
STRAP0 = Stuff 49.9k pull up
STRAP1 = NC
STRAP2 = NC
STRAP3 = NC
STRAP4 = NC
ROM_SI = VRAM Configuration follow below table

N16V-GM DID=0x1299 [920M]

ROM_SCLK = Stuff 4.99k pull up
ROM_SO = Stuff 4.99k pull up
STRAP0 = Stuff 45.3k pull up. (EDID Panel)
STRAP1 = Stuff 45.3k pull down. (Gen3 support)
STRAP2 = Stuff 10k pull up. (DID 0x1299)
STRAP3 = Stuff 4.99k pull down. (No display out)
STRAP4 = Stuff 45.3k pull down. (Gen3/max speed)
ROM_SI = VRAM Configuration follow below table

Note: GC6 2.0 is supported by N16x GPU in the GB28 ,GB4B-128, and GB3B-256 packages.



GPIO ASSIGNMENTS

GPIO	I/O	PIN	USAGE
0	IN	FB_CLAMP_MON	FB Clamp monitor (GC6 1.0)
0	OUT	GC6_FB_EN	GC6 FB Enable (GC6 2.0)
5	OUT	+3V_MAIN_EN	Enable GC6 +3V_MAIN
6	OUT	FB_CLAMP_REQ#	Active low FB Clamp toggle request (GC6 1.0)
6	IN	DGPU_EVENT#	DGPU EVENT from CPU (GC6 2.0)
8	OUT	VGA_OVT#	ACTIVE LOW THERMAL OVER TEMP
9	OUT	ALERT	ACTIVE LOW THERMAL ALERT
11	OUT	PWR_VID	GPU CORE_VDD PWM Control signal
12	IN	PWR_LEVEL	AC Power detect or power supply overdraw input
13	OUT	PSI	Phase Shedding

N16S-GT/N16V-GM Strapping table

ROM_SI	N16S-GT [940M]
2G Hynix 128Mx16	-->34.8K PD
2G Micron 128Mx16	-->45.3K PD
2G Samsung 128Mx16	-->4.99K PU
4G Hynix 256Mx16	-->30.1K PU Single Rank
4G Hynix 256Mx16	-->24.9K PU Dual Rank
4G Micron 256Mx16	-->10K PD
4G Samsung 256Mx16	-->15K PD

Resistor P/N
4.99K --> CS24992FB26
10K --> CS31002FB26
15K --> CS31502FB24
20K --> CS32002FB29
24.9K --> CS32492FB16
30.1K --> CS33012FB18
34.8K --> CS33482FB22
45.3K --> CS34532FB18 GM
49.9K --> CS34992FB10 GT

Logical Strap Bit Mapping

	PU-VDD	PD
4.99K	1000	0000
10K	1001	0001
15K	1010	0010
20K	1011	0011
24.9K	1100	0100
30.1K	1101	0101
34.8K	1110	0110
45.3K	1111	0111

ROM_SO	N16S-GT --> 4.99K PD
N16V-GM	--> 4.99K PU

ROM_SCLK	N16S-GT --> 4.99K PD
N16V-GM	--> 4.99K PU

STRAP0	N16S-GT --> 49.9K PU
N16V-GM	--> 45.3K PU

N16S-GM/GT/LP VRAM Configuration Table ROM_SI

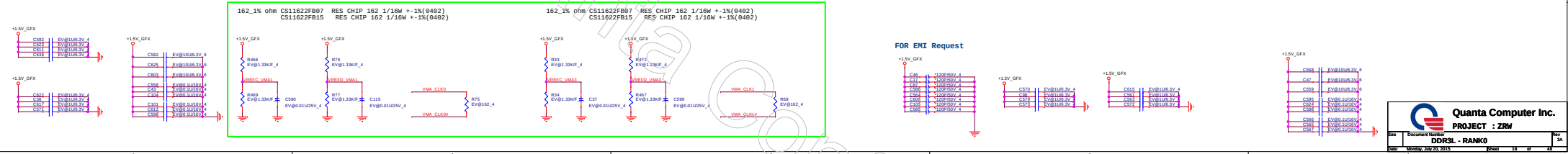
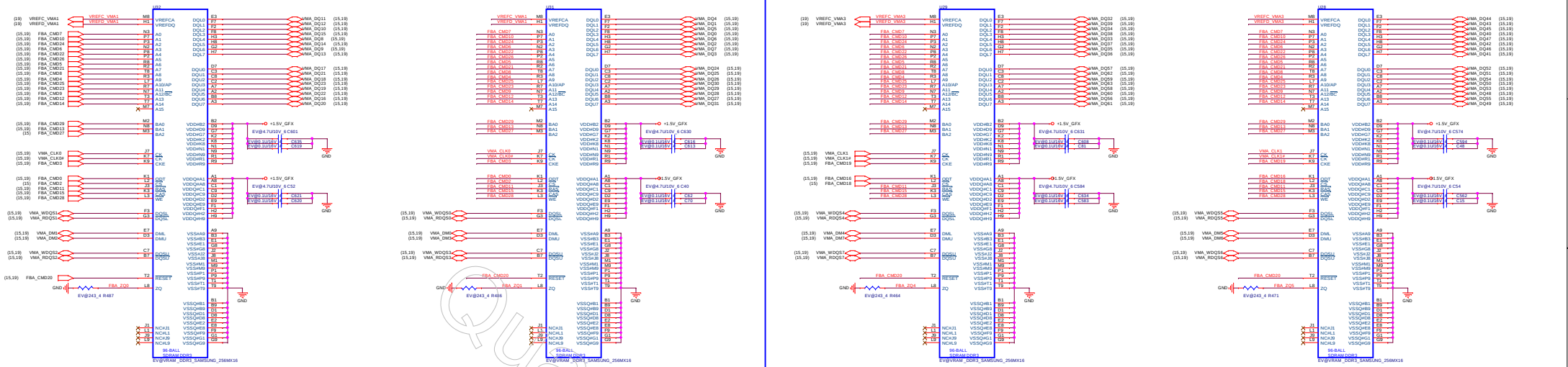
RAMCFG [3:0]	DESCRIPTION	1.5V DDR3	Vendor	Vendor P/N	ROM_SI	STN B/S	Configuration
0101 0x5	DDR3L 256Mx16, 64bit, 4Gb,1000MHz		HYNIX C-die	H5TC4G63CFR-N0C	PD 30.1K ohm	AKD5PZDTW03	Single Rank 2GB
1100 0xC	DDR3L 256Mx16, 64bit, 4Gb,1000MHz		HYNIX C-die	H5TC4G63CFR-N0C	PU 24.9K ohm	AKD5PZDTW03	Dual Rank 4GB
0001 0x1	DDR3L 256Mx16, 64bit, 4Gb,1000MHz		Micron E-die	MT41J256M16HA-093G:E	PD 10K ohm	AKD5PZSTL05	Single Rank Dual Rank
0010 0x2	DDR3L 256Mx16, 64bit, 4Gb,1000MHz		SAMSUNG D-die	K4W4G1646D-BC1A	PD 15K ohm	AKD5PGWT504	Single Rank Dual Rank
0100 0x4	DDR3L 256Mx16, 64bit, 4Gb,1000MHz		SAMSUNG E-die	K4W4G1646E-BC1A	PD 24.9K ohm	AKD5PGDT504	Single Rank 2GB
1101 0xD	DDR3L 256Mx16, 64bit, 4Gb,1000MHz		SAMSUNG E-die	K4W4G1646E-BC1A	PU 30.1K ohm	AKD5PGDT504	Dual Rank 4GB

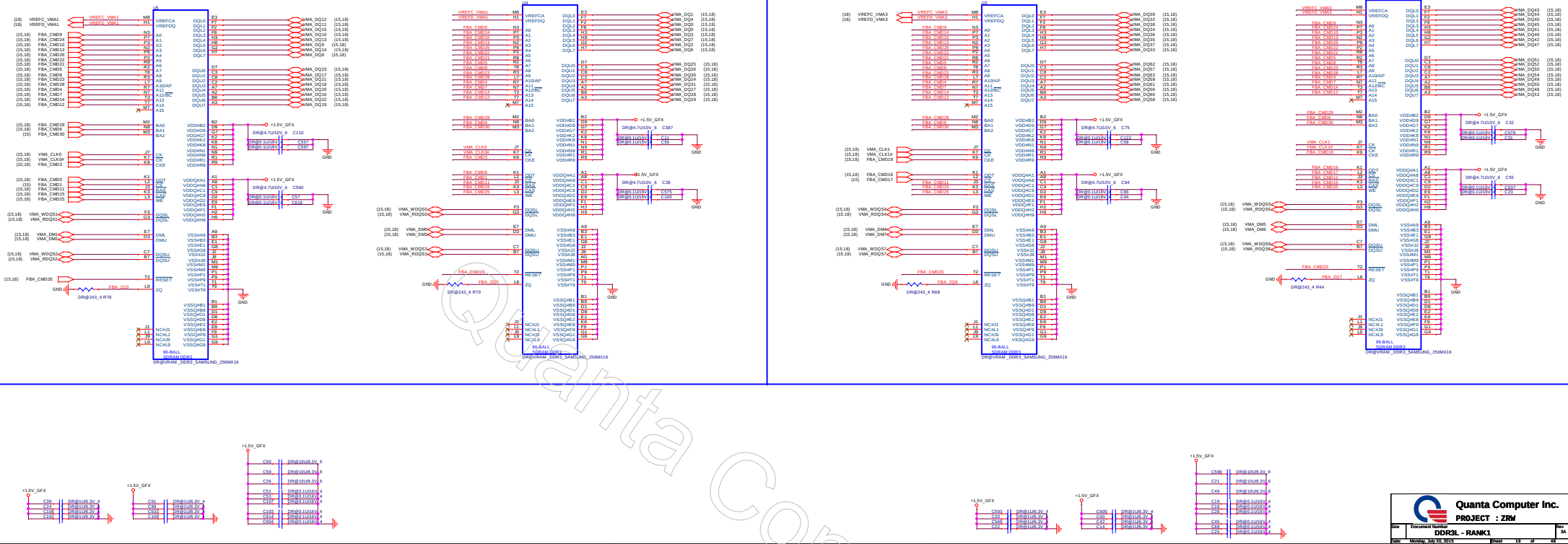
N16V-GM/GL VRAM Configuration Table ROM_SI

RAMCFG [3:0]	DESCRIPTION	1.5V DDR3	Vendor	Vendor P/N	ROM_SI	STN B/S	Configuration
0001 0x1	DDR3L 256Mx16, 64bit, 4Gb,1000MHz		Micron E-die	MT41J256M16HA-093G:E	PD 10K ohm	AKD5PZSTL05	Single Rank or Single Rank stuffing for Dual Rank
1001 0x9	DDR3L 256Mx16, 64bit, 4Gb,1000MHz		HYNIX C-die	H5TC4G63CFR-N0C	PU 10K ohm	AKD5PZDTW03	
0100 0x4	DDR3L 256Mx16, 64bit, 4Gb,1000MHz		SAMSUNG D-die	K4W4G1646D-BC1A	PD 24.9K ohm	AKD5PGWT504	
1010 0xA	DDR3L 256Mx16, 64bit, 4Gb,1000MHz		SAMSUNG E-die	K4W4G1646E-BC1A	PU 15K ohm	AKD5PGDT504	

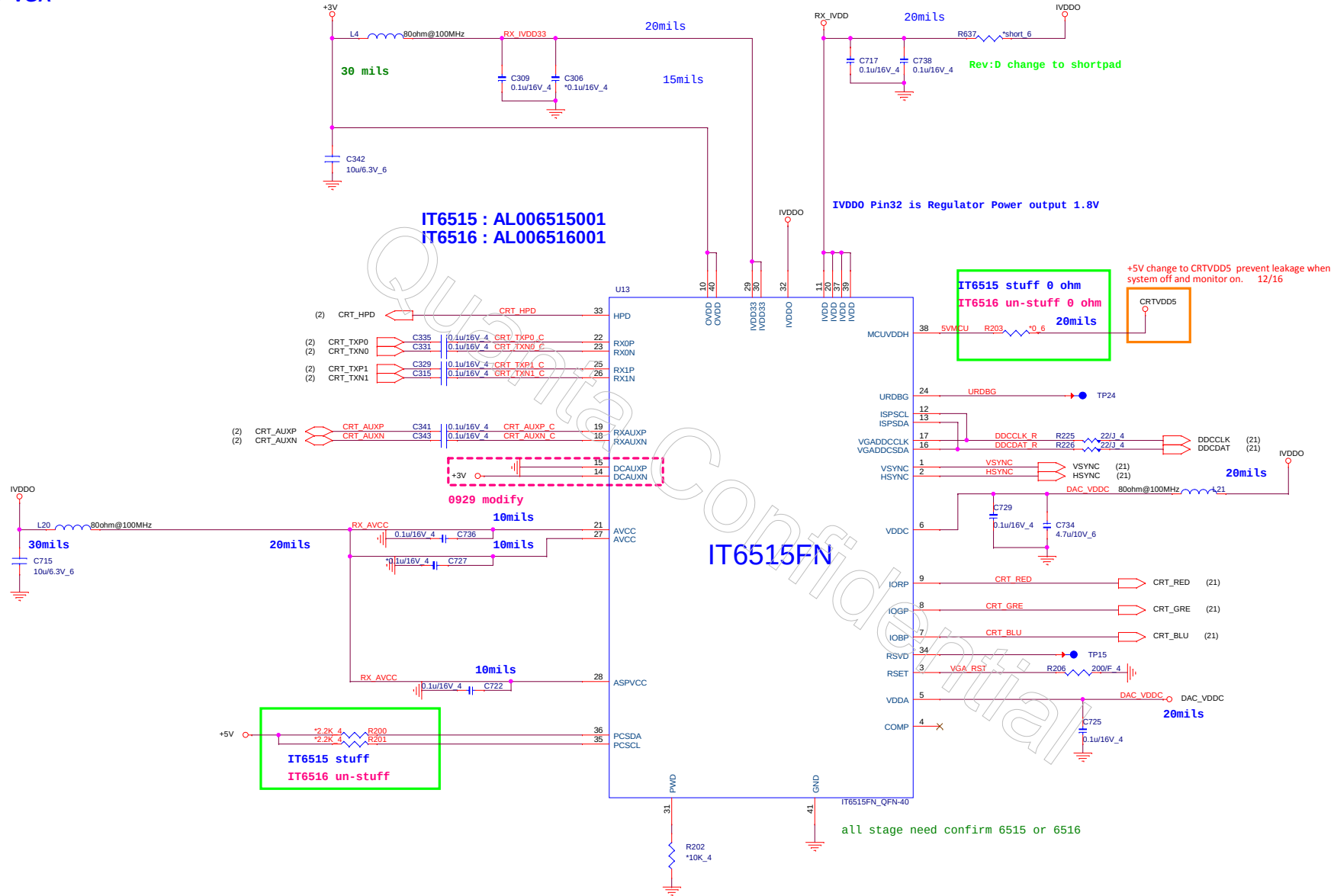
N16V-GM strap0-3 table

STRAP0 = Stuff 45.3k pull up. (EDID Panel)
STRAP1 = Stuff 45.3k pull down. (Gen3 support)
STRAP2 = Stuff 10k pull up. (DID 0x1299)
STRAP3 = Stuff 4.99k pull down. (No display out)
STRAP4 = Stuff 45.3k pull down. (Gen3/max speed)



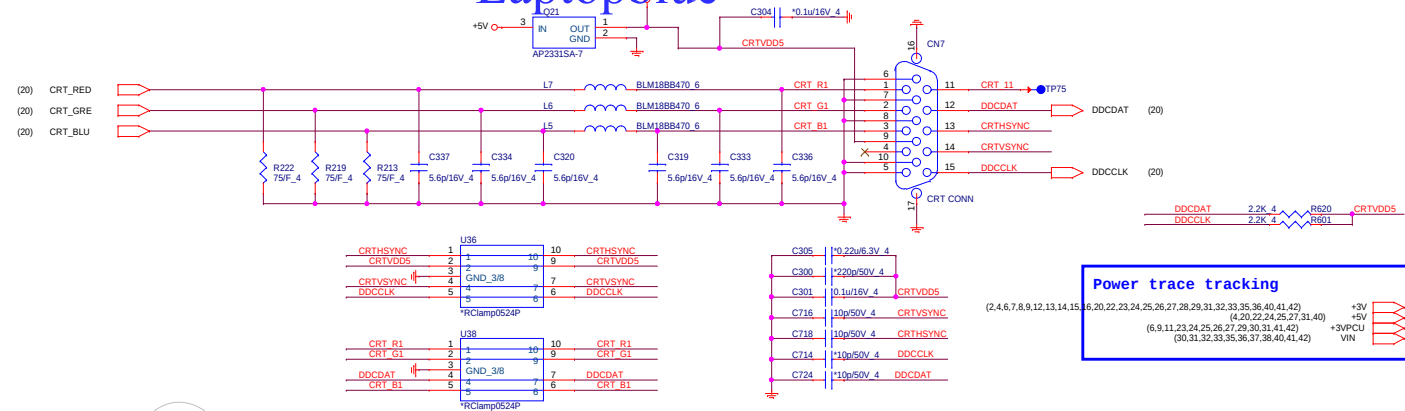
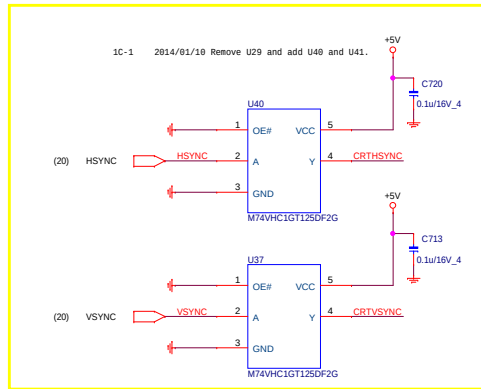


DP TO VGA

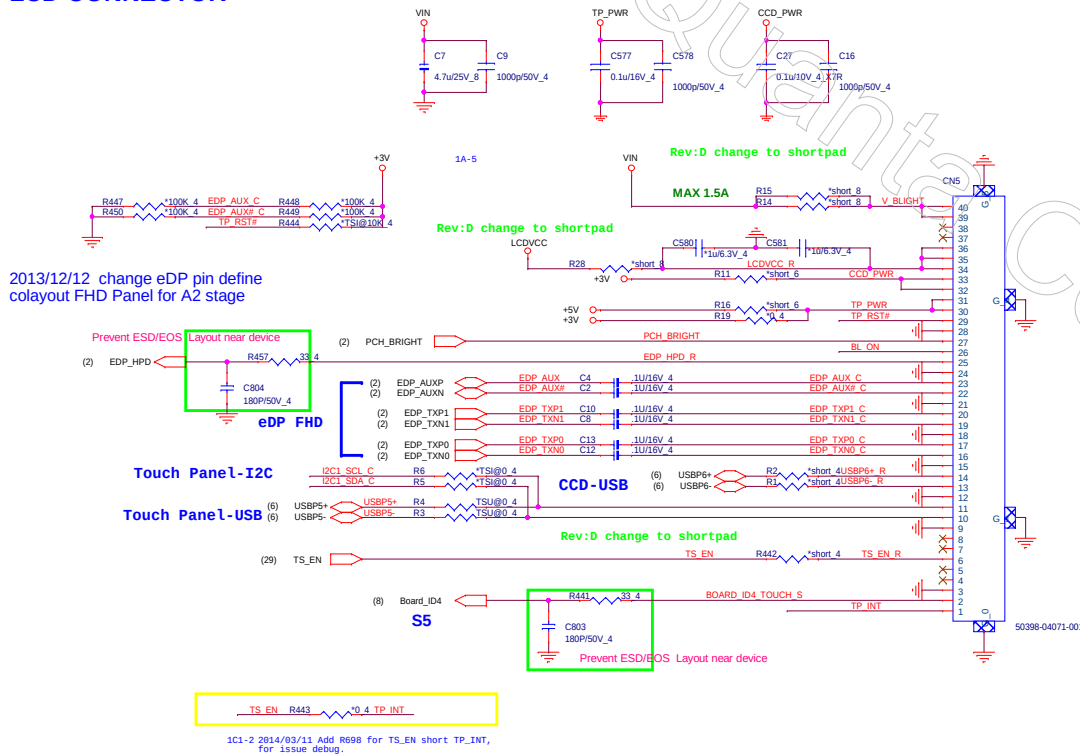


(2,4,6,7,8,9,12,13,14,15,16,21,22,23,24,25,27,28,31,32,35,36,40,41,42)
 (4,21,22,24,25,27,31,40)

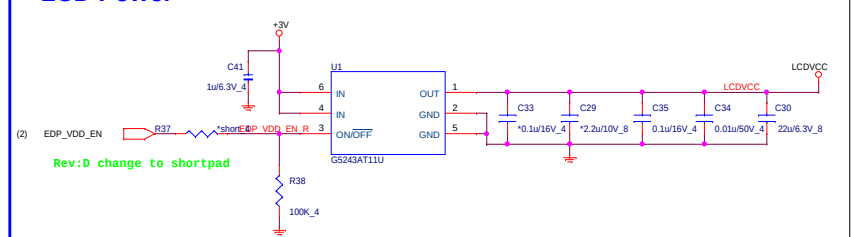
+3V
 +5V



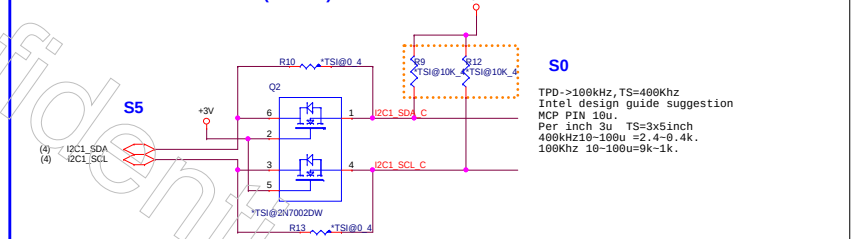
LCD CONNECTOR



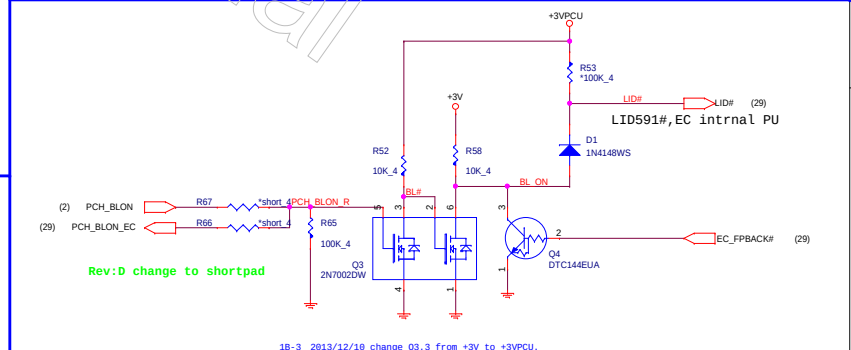
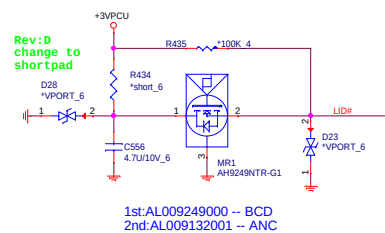
LCD Power



Touch screen level shift I2C(reserve)

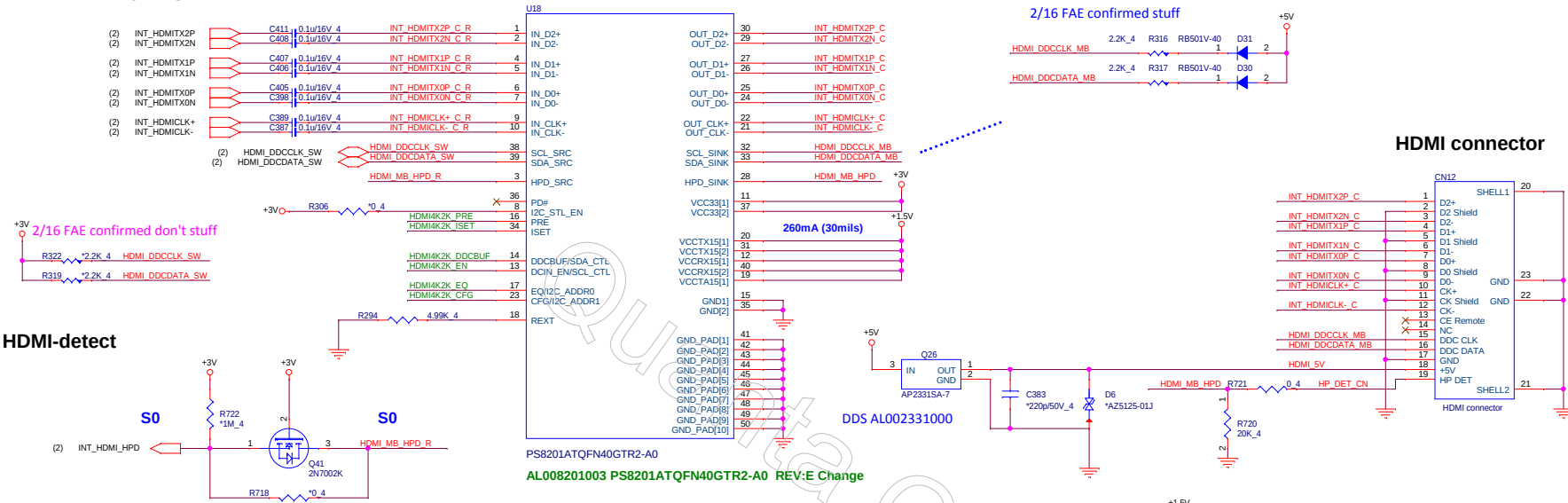


Hall Sensor (HSR)

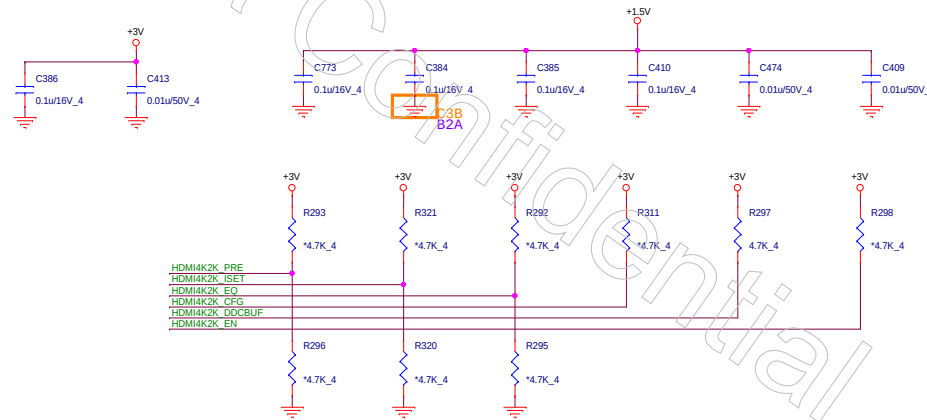
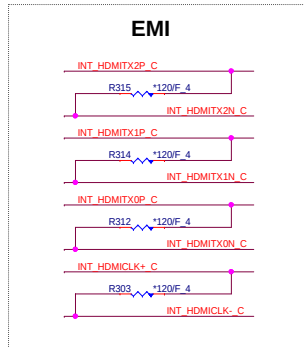


<HDM>

From PCH



EMI



	Pre	ISET	EQ	CFG	DDCBUF	DCIN_EN
NC(Low)	0	dB	default	12.4	dB HDMI ID disable	default, AC coupling input
1(High)	1.6	dB	+13%	4.3	dB HDMI ID enable	active DDC buffer with default threshold
M	2.5	dB	-13%	8.6	dB N/A	active DDC buffer without internal pull up resistor

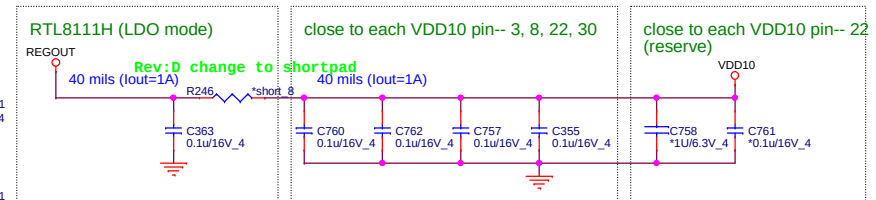
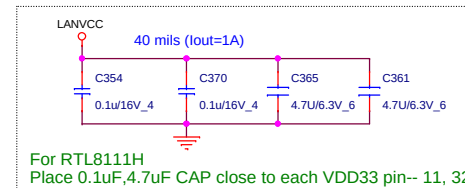
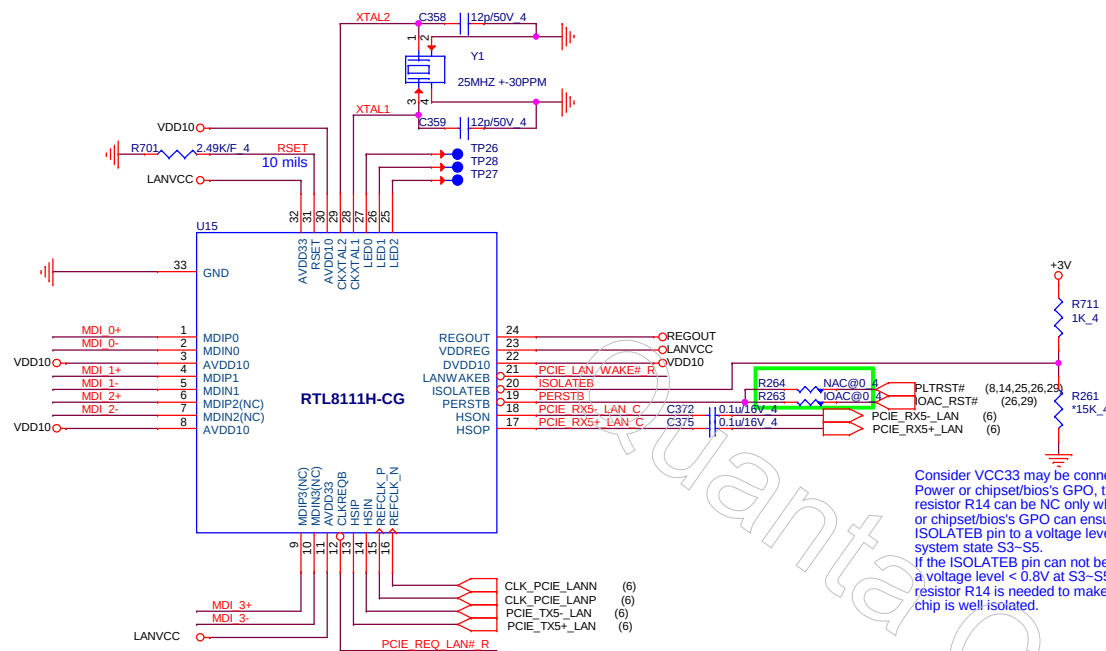
Power trace tracking

(2,4,6,7,8,9,12,13,14,15,16,20,21,23,24,25,26,27,28,29,31,32,33,35,36,40,41,42)
(4,20,21,24,25,27,31,40)

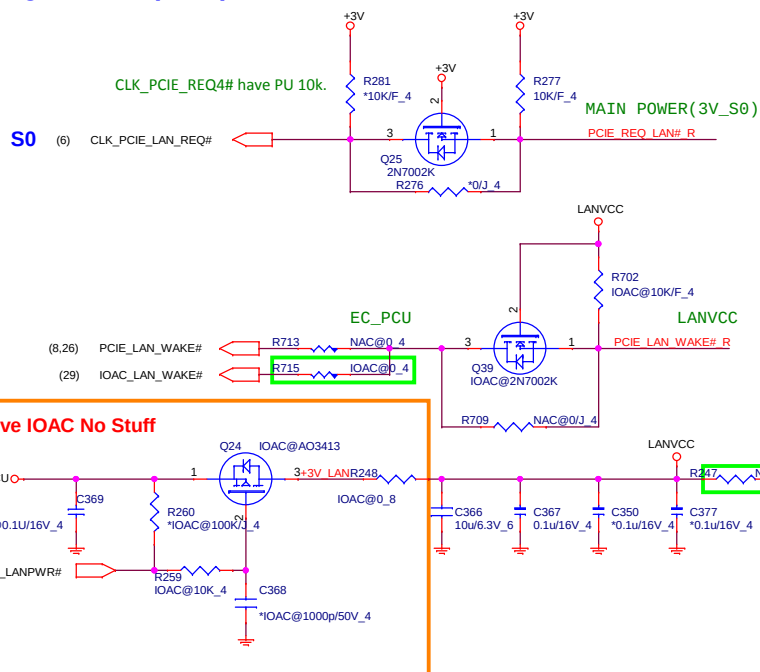
+3V
+5V

Pre	Output pre-emphasis setting
ISET	TMDS output swing adjustment
EQ	Receiver equalization setting
CFG	Configuration pin
DDCBUF	enable active DDC buffer
DCIN_EN	DC coupling enable

Pin	PS8401A	PS8201A
12	VDDRX	NC
15	GND	NC
34	ISET	NC
37	VDD33	NC

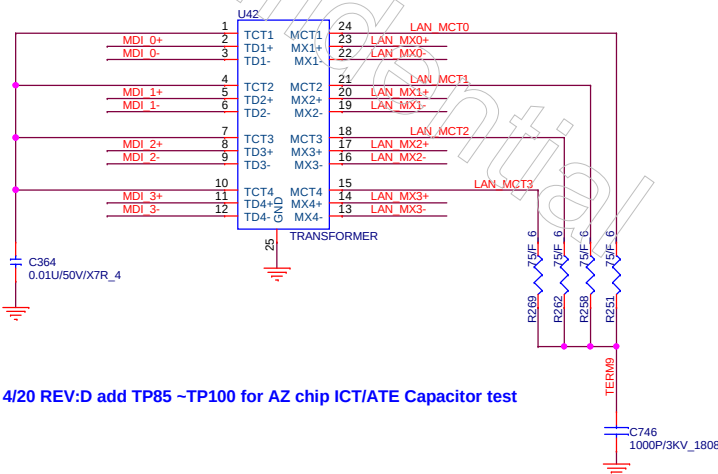


Leakage circuit (MPC)

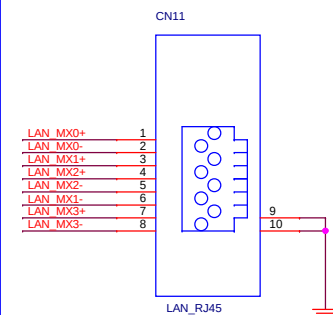


Transformer

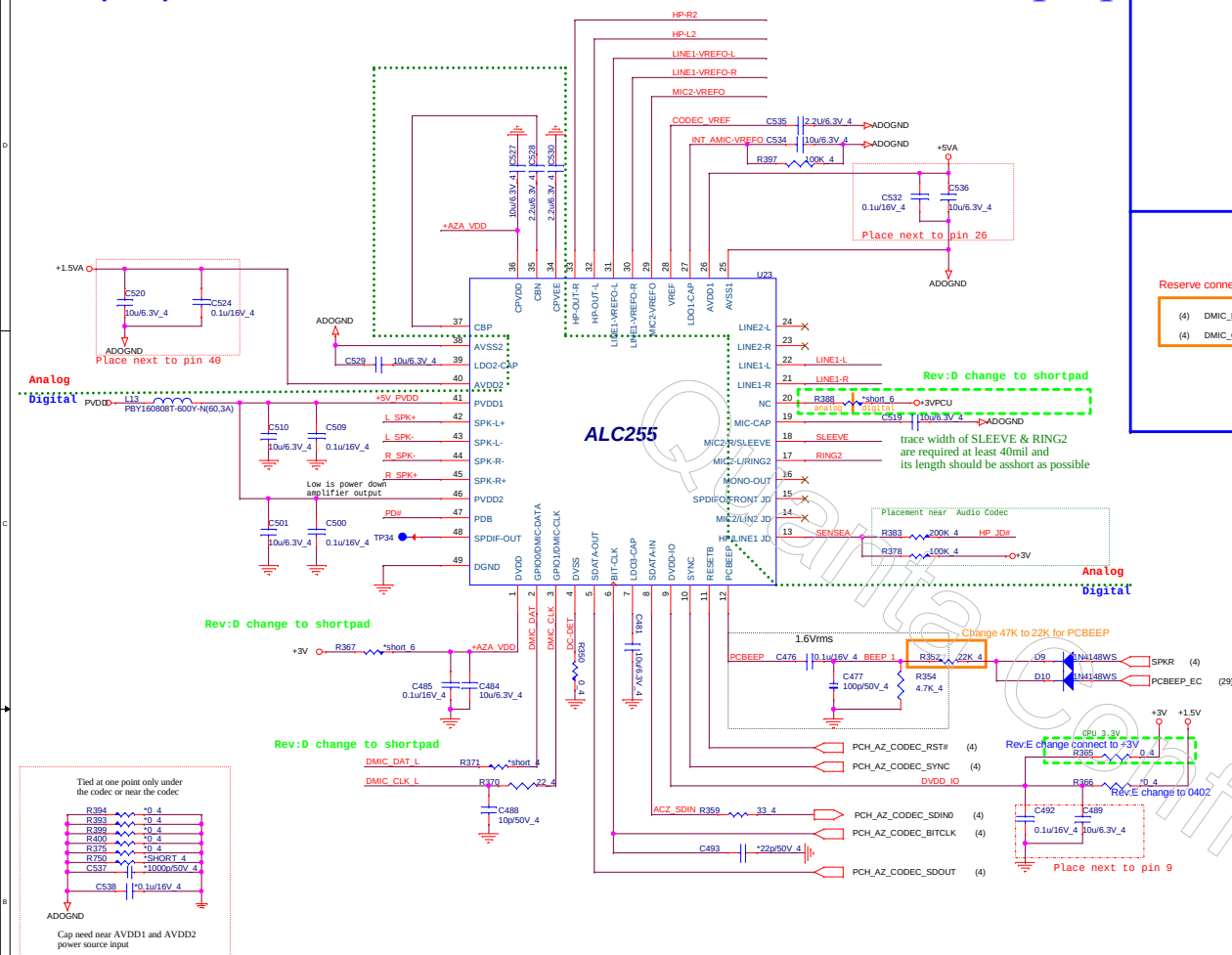
Layout: All termination signal should have 30 mil trace



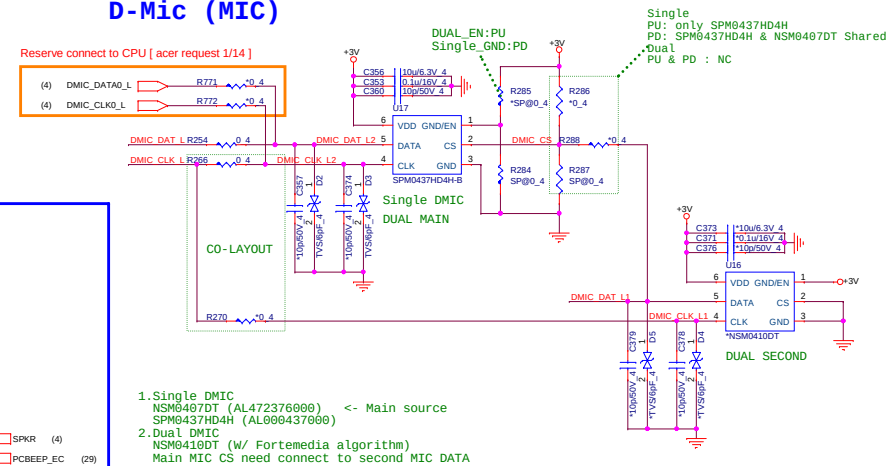
RJ45 Connector



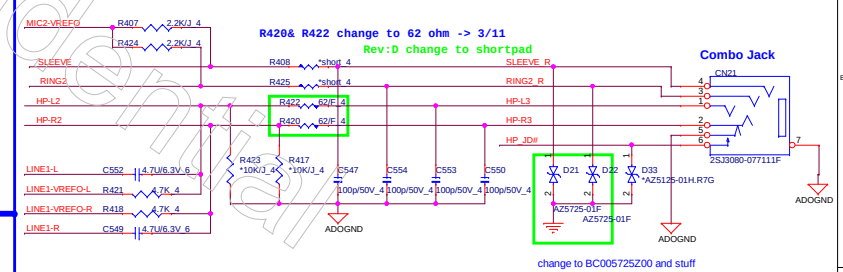
Codec(ADO)



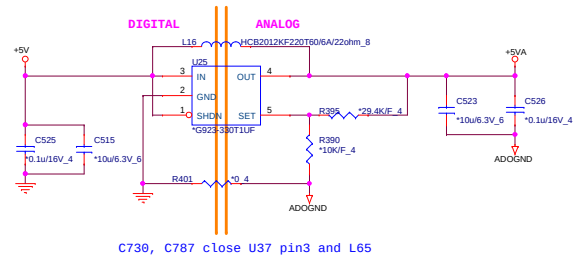
D-Mic (MIC)



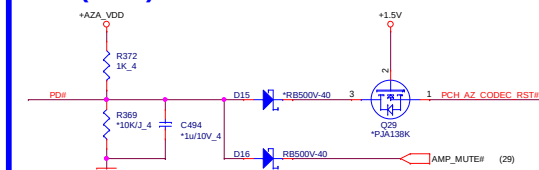
Universal Audio Jack HEADPHONE/MIC/LINE combo (ADO)



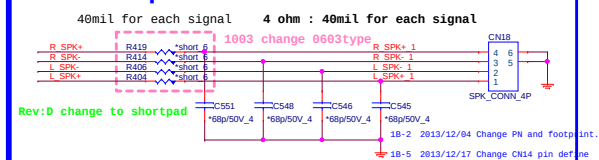
Codec PWR 5V(ADO)



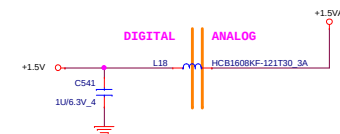
Mute(ADO)



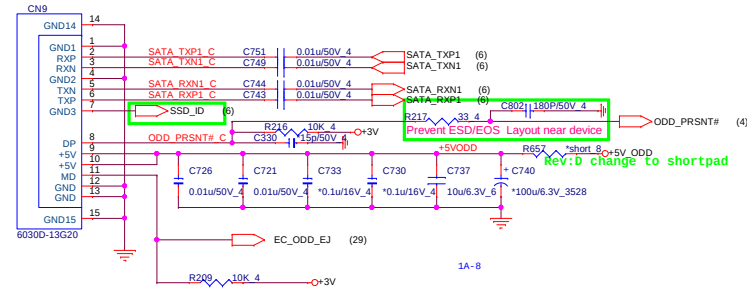
Internal Speaker



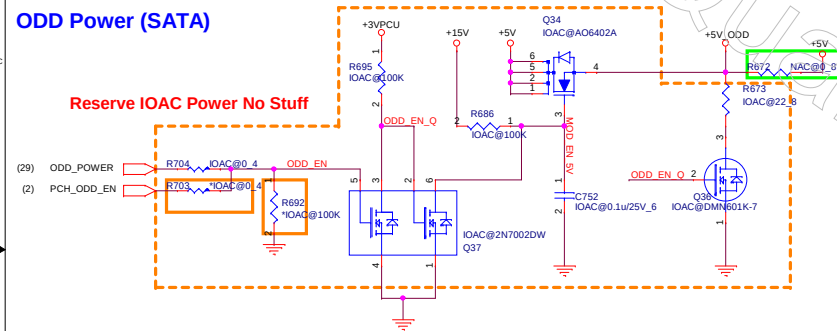
Codec PWR 1.5V(ADO)



25



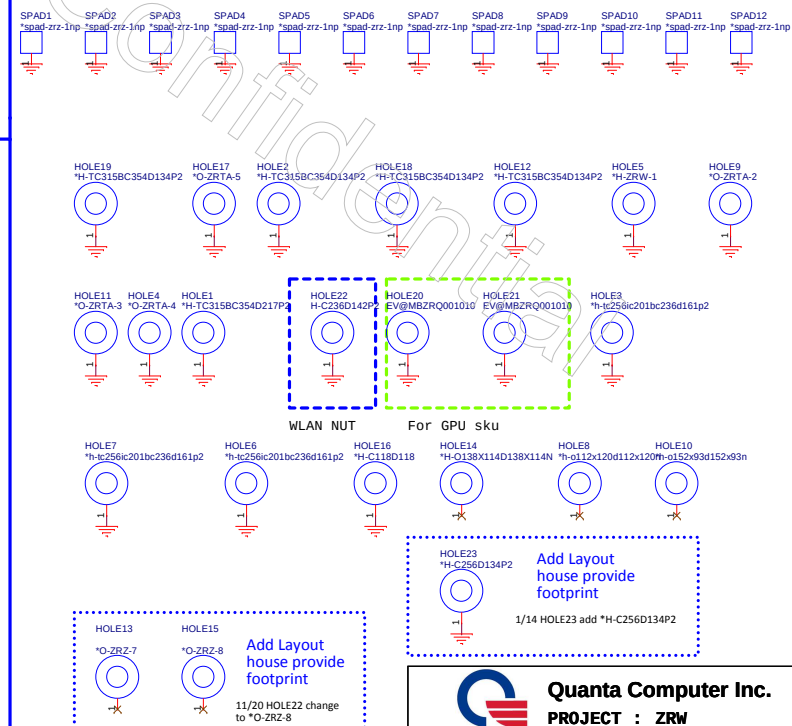
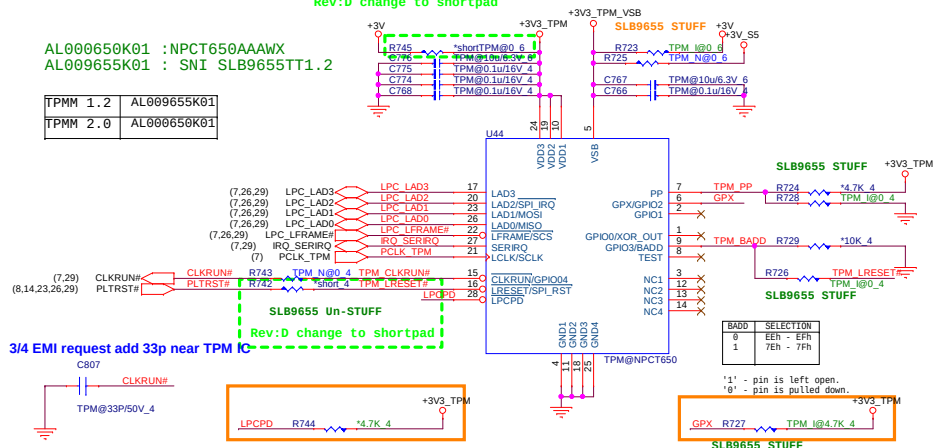
Reserve IOAC Power No Stuff



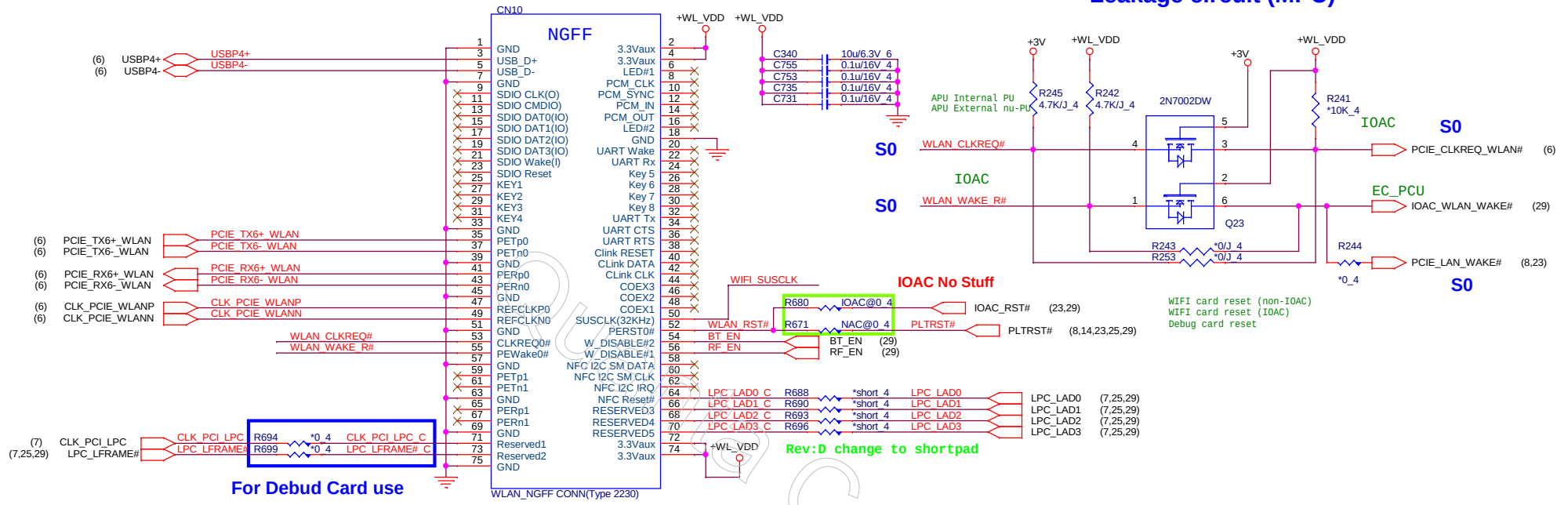
SP@ BOM周邊上NPCT650
A,B,C P/N:AL009655K01(SLB9655TT1.2- FW4.31)
RAMP P/N: AL000650K01 (NPCT650AAAWX)

Rev:D change to shortpad

TPMM 1.2	AL009655K01
TPMM 2.0	AL000650K01

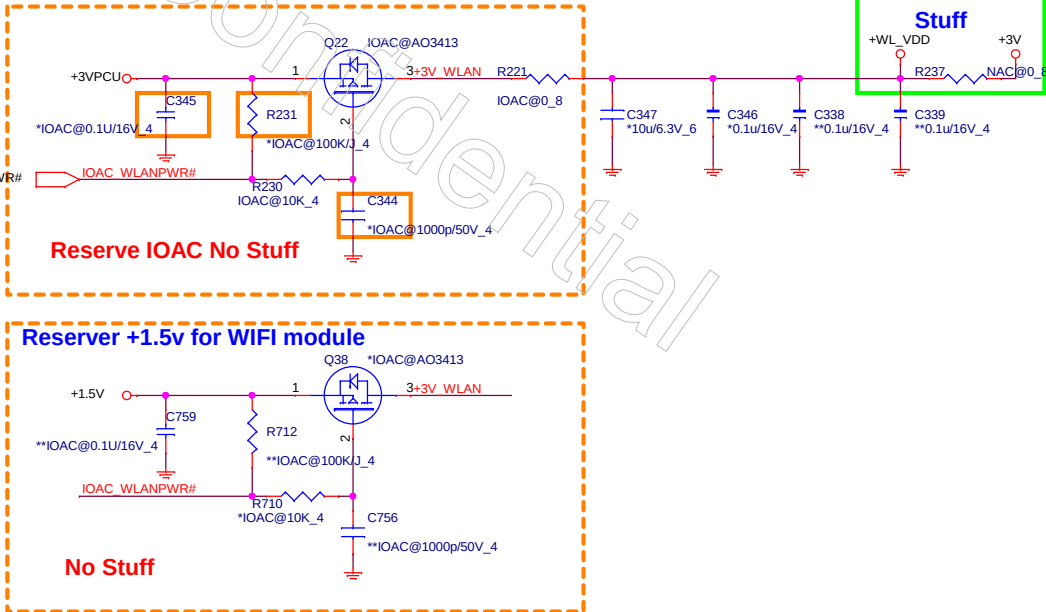
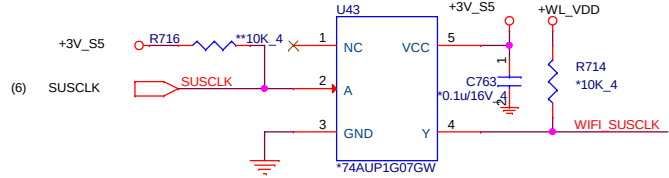


Leakage circuit (MPC)

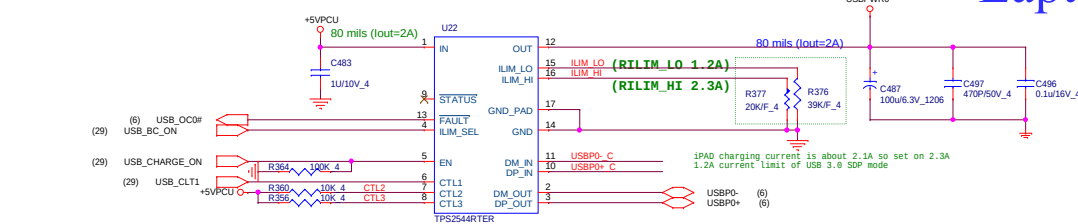


Low	Mini card +3V power enable
High	Mini card +3V power disable

Reserve only for Intel module no need to stuff by default 11/24



USB Charger to 3.0 (UBC)



GMT:AL003703000(G3703)
TI:AL002544001(TPS2544)
Silergy: AL055544000 (SLGC55544VTR)

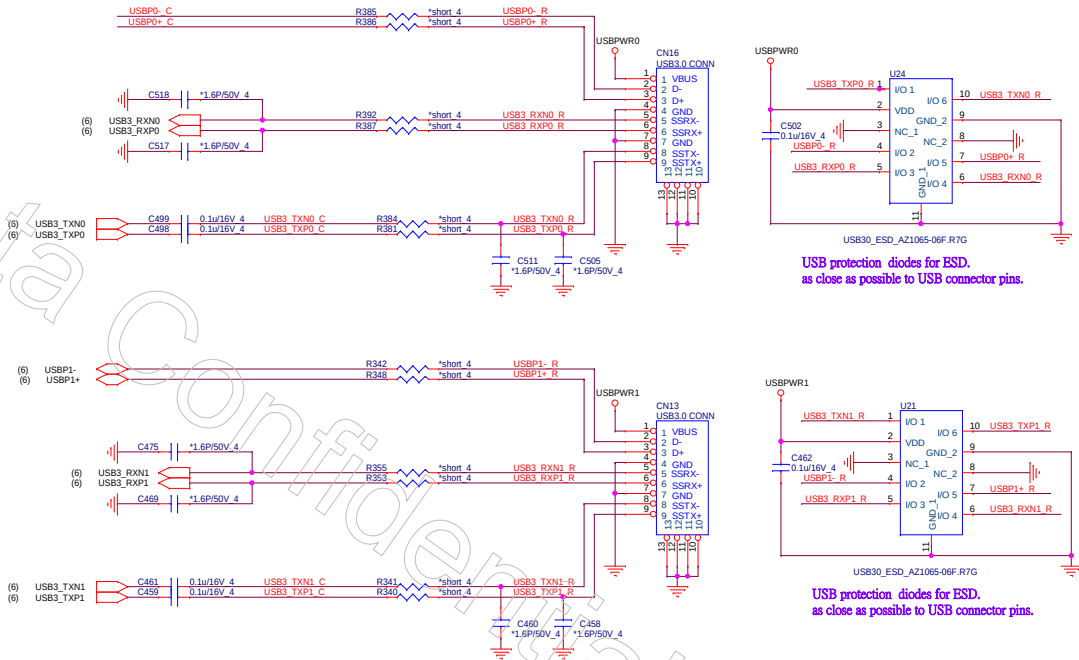
Laptopblue

	CTL1	CTL2	CTL3	ILIM_SEL
SDP	1	1	1	0
CDP	1	1	1	1
DCP	0	1	1	X

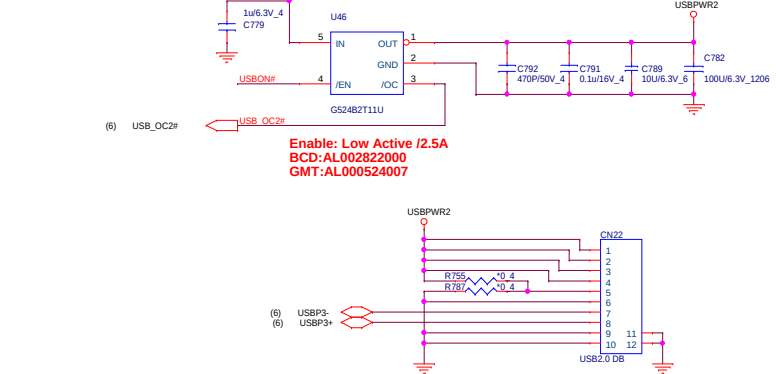
RILIM_L0 is optional and the ILIM_L0 pin may be left unconnected if the following conditions are met:
1. ILIM_SEL is always set high
2. Load Detection - Port Power Management is not used
3. Mouse / keyboard wake function is not used
If conditions 1 and 2 are met but the mouse / keyboard wake function is also desired, it is recommended to use
RILIM_L0 < 80.6 kΩ.
The following equation programs the typical current limit:
(1) $I_{OS\_typ}(mA) = 50,250 / (RILIM\_XX(K\Omega) + 0.1)$
RILIM_XX corresponds to either RILIM_HI or RILIM_L0 as appropriate.

USB 3.0 Connector (UB3)

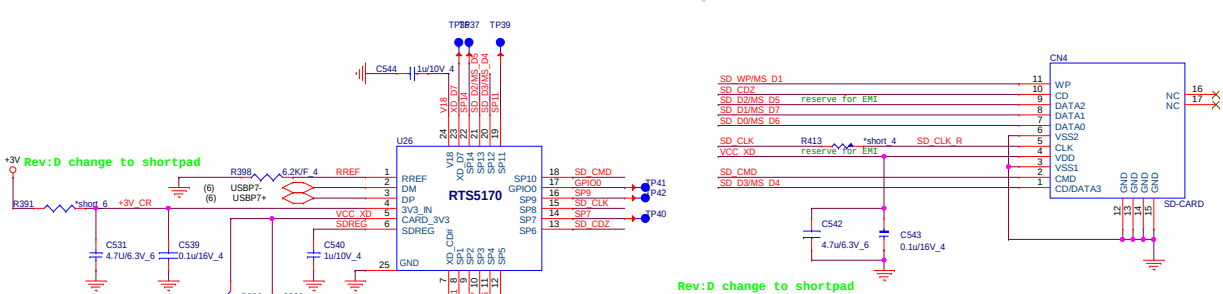
Rev:D change to shortpad

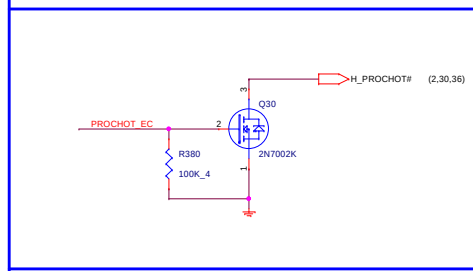
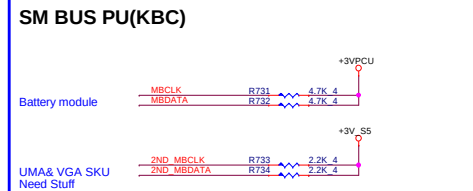
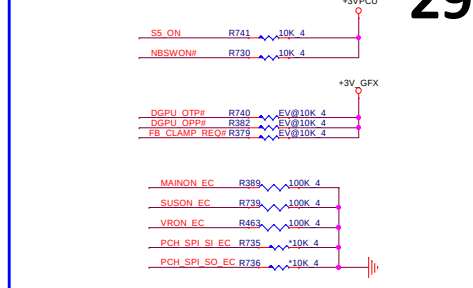
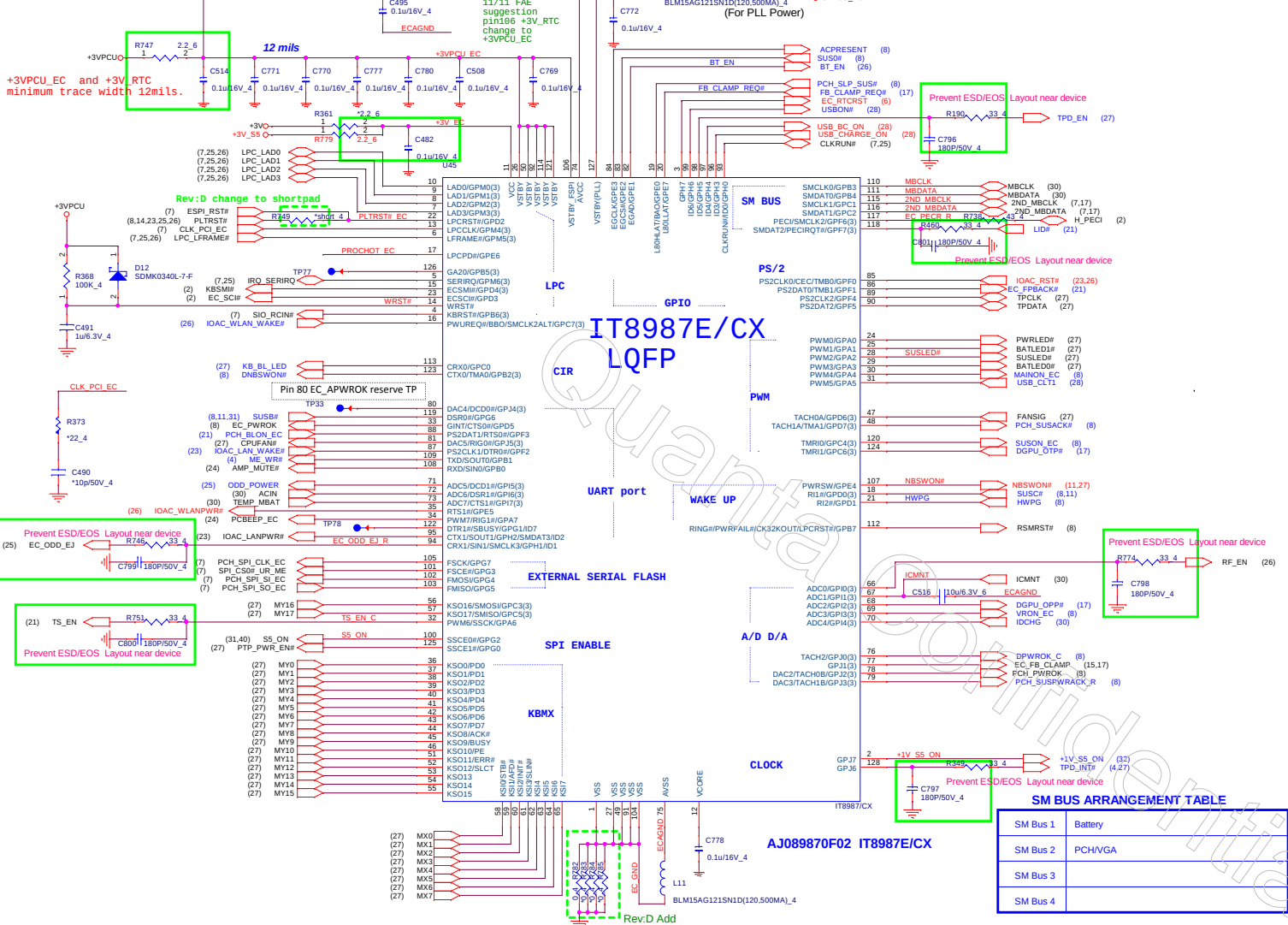


USB2.0 DB (UB2)



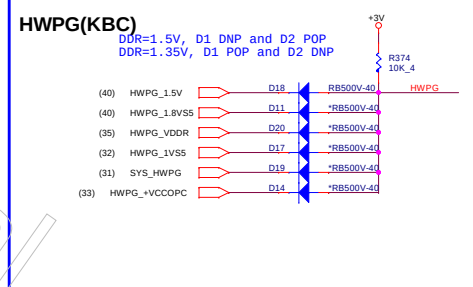
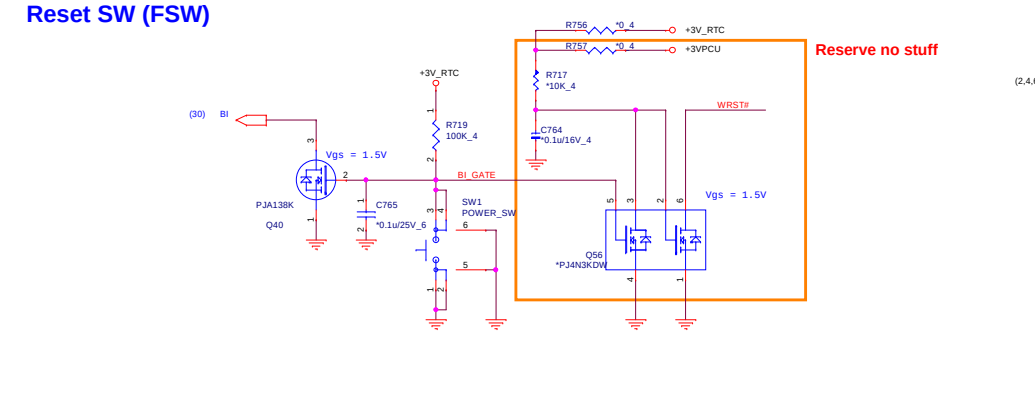
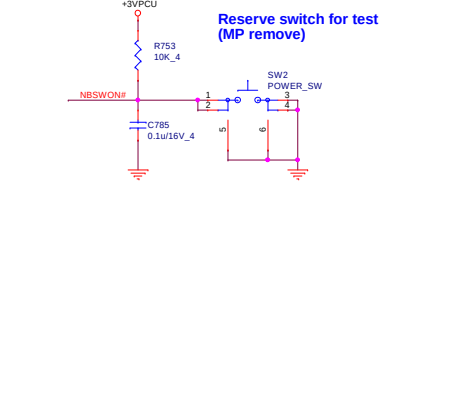
Card Reader (CRD)

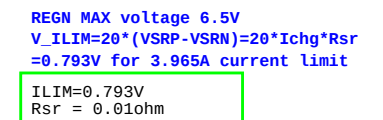


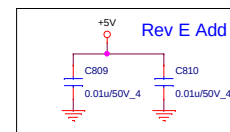


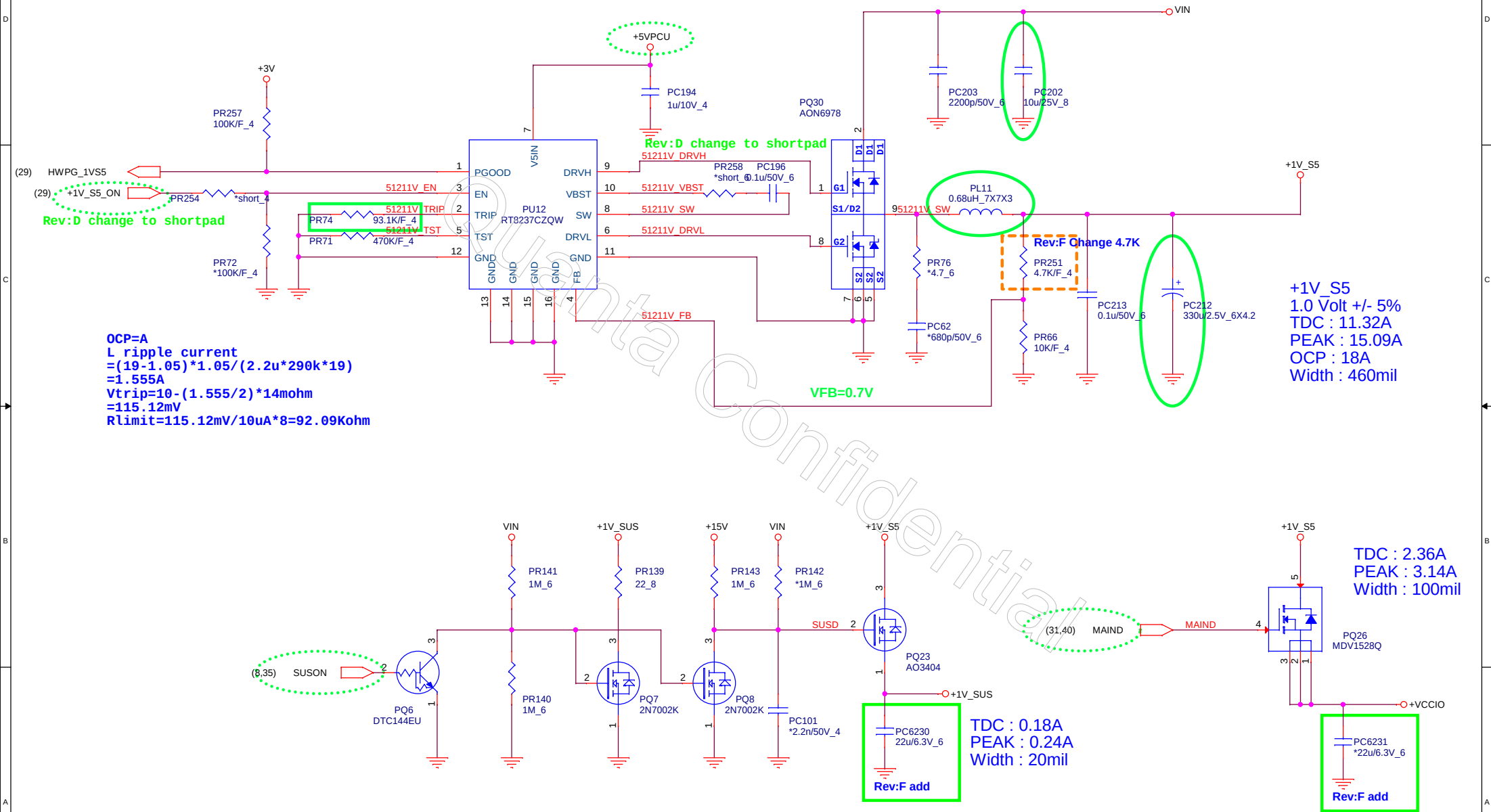
SM BUS ARRANGEMENT TABLE

SM Bus 1	Battery
SM Bus 2	PCH/VGA
SM Bus 3	
SM Bus 4	









Quanta Computer Inc.

PROJECT : ZRW

Size	Document Number	Rev
	+1V_S5 (RT8237CZQW)	3A
Date:	Monday, July 20, 2015	Sheet 32 of 48

 Quanta Computer Inc. PROJECT : ZRW		
Size	Document Number	Rev
	+VCCOPC (NB681GD-Z)	3A
Date:	Monday, July 20, 2015	Sheet 33 of 48

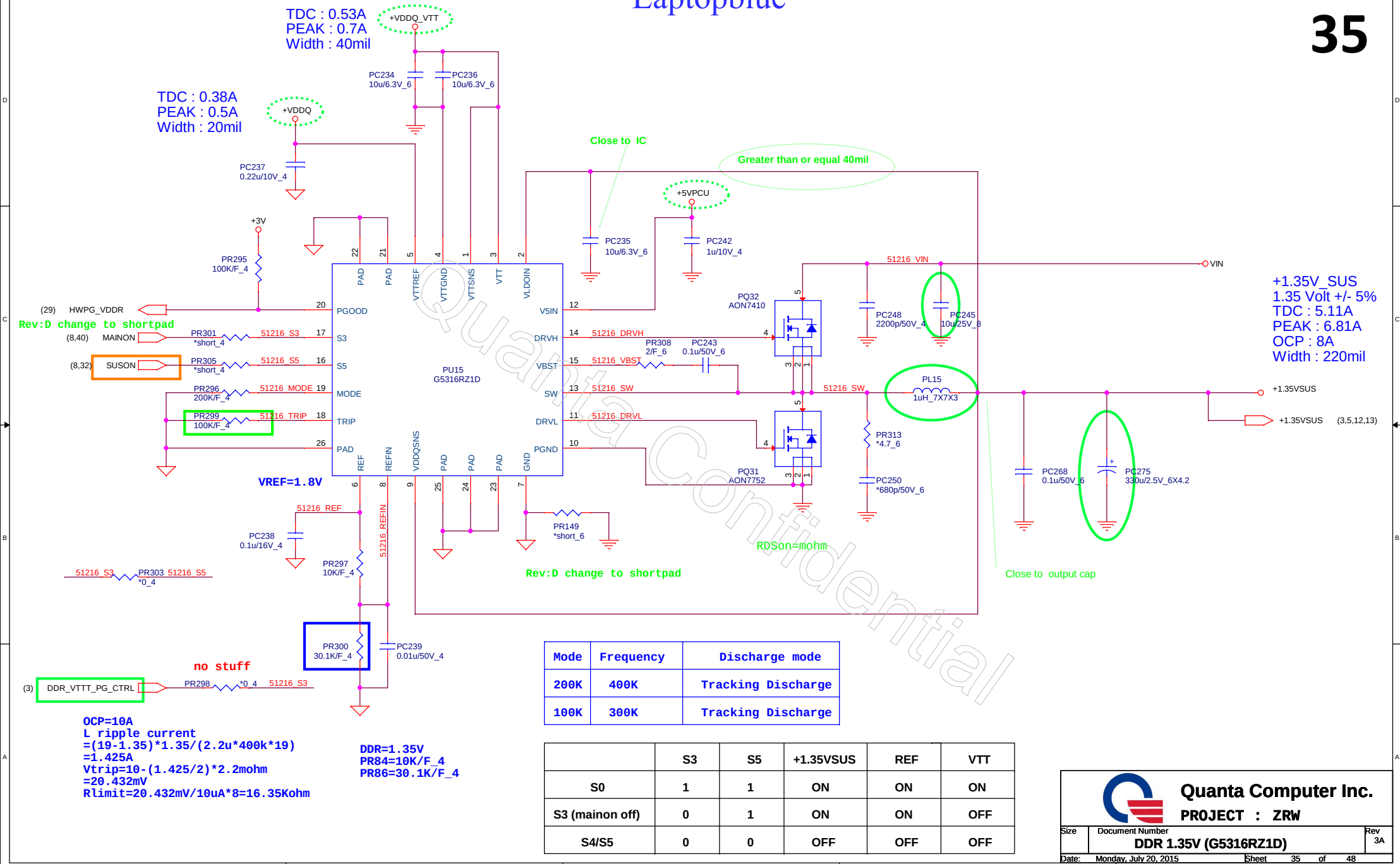
Quanta Confidential

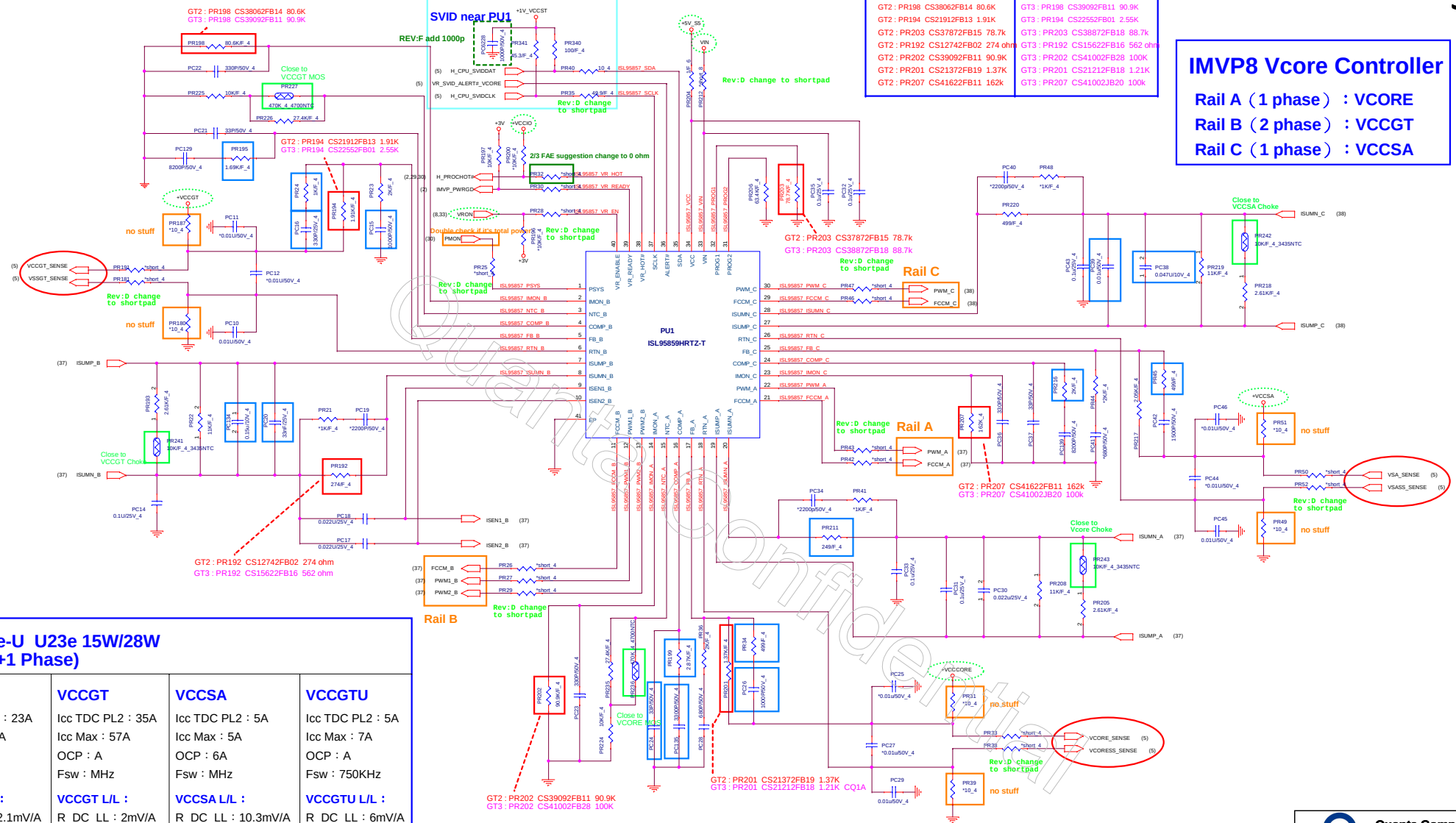


Quanta Computer Inc.

PROJECT : ZRW

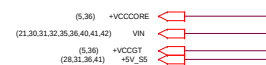
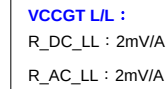
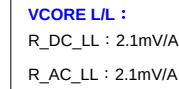
Size	Document Number	Rev
	+VCCEPIO (NB681GD-Z)	2A
Date: Thursday, June 25, 2015		Sheet 34 of 48

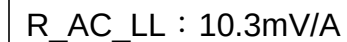




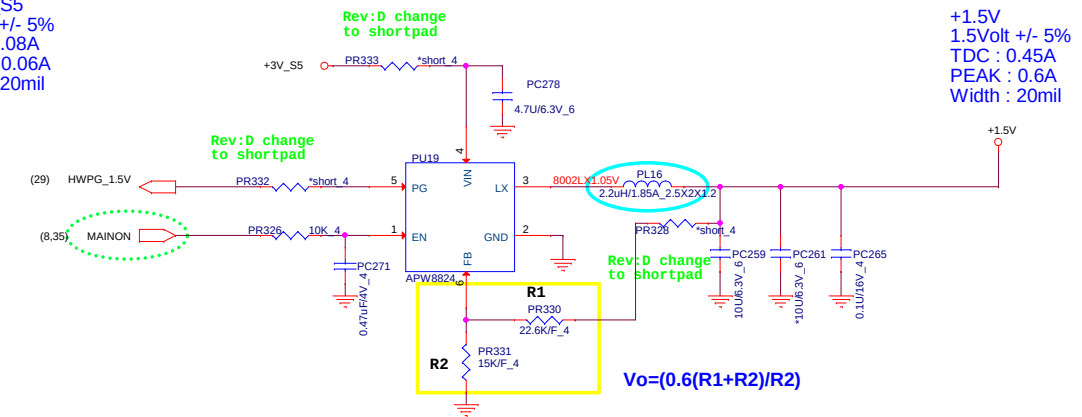
Skylake-U U23e 15W/28W (1+2+1+1 Phase)

VCCORE	VCCGT	VCCSA	VCCGTU
Icc TDC PL2 : 23A	Icc TDC PL2 : 35A	Icc TDC PL2 : 5A	Icc TDC PL2 : 5A
Icc Max : 29A	Icc Max : 57A	Icc Max : 5A	Icc Max : 7A
OCp : 35A	OCp : A	OCp : 6A	OCp : A
Fsw : MHz	Fsw : MHz	Fsw : MHz	Fsw : 750KHz
VCCORE L/L :	VCCGT L/L :	VCCSA L/L :	VCCGTU L/L :
R_DC_LL : 2.1mV/A	R_DC_LL : 2mV/A	R_DC_LL : 10.3mV/A	R_DC_LL : 6mV/A
R_AC_LL : 2.1mV/A	R_AC_LL : 2mV/A	R_AC_LL : 10.3mV/A	R_AC_LL : 6mV/A

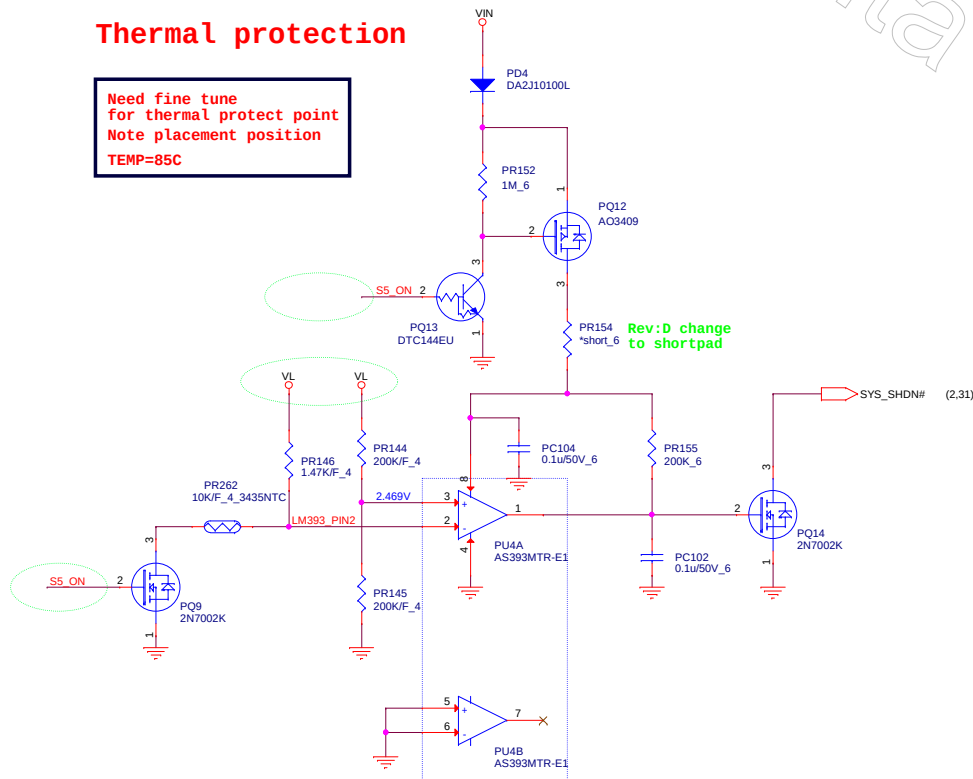




Quanta Confidential

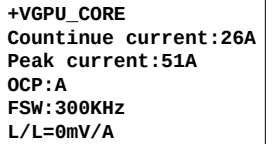


Need fine tune
for thermal protect point
Note placement position
TEMP=85C



Rev:C change to 220 ohm
PR153 Change to 220 ohm for bo bo sound issue.

Rev:D Stuff





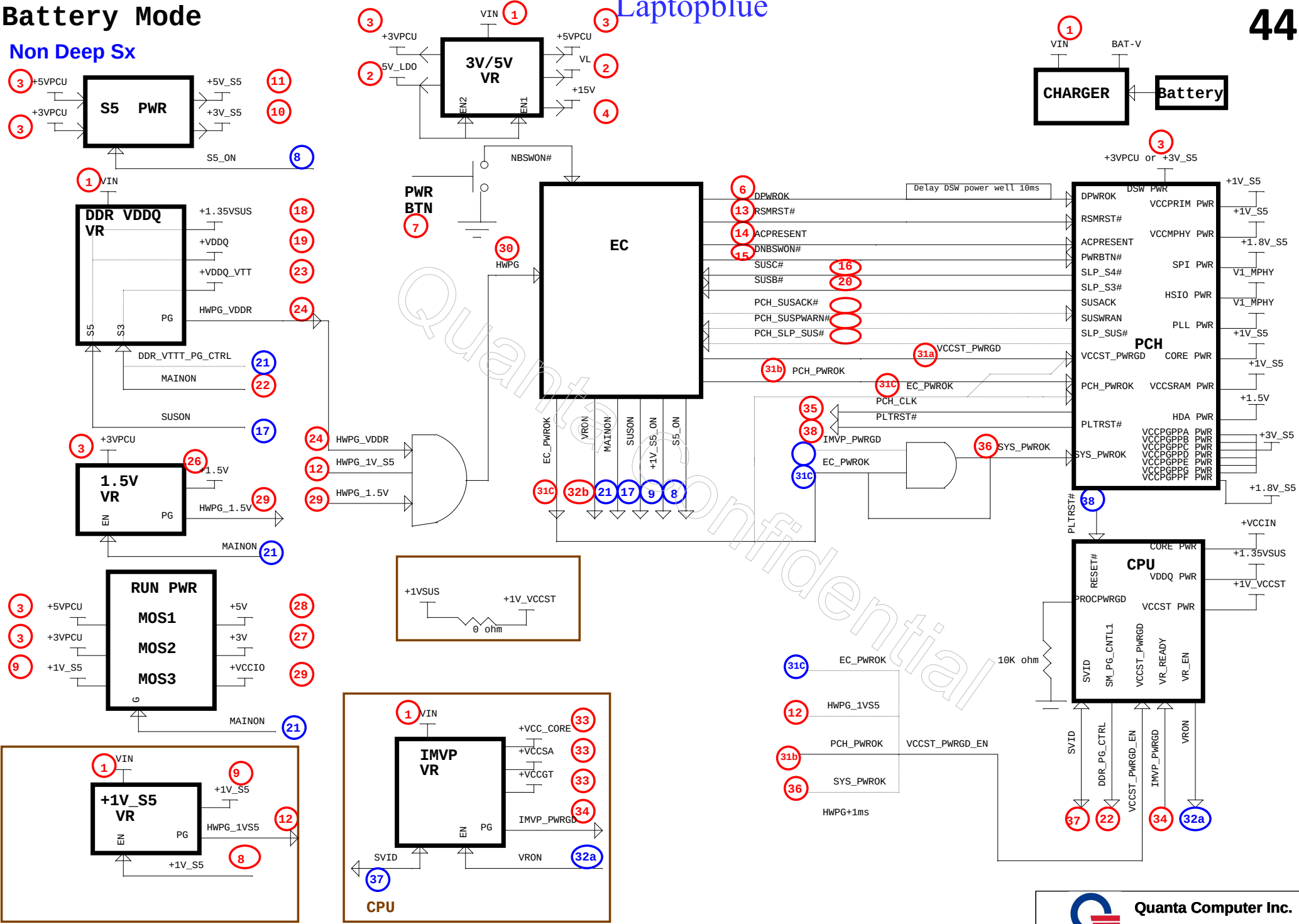
+1.5V_GFX
1.5 Volt +/- 5%
TDC : 4.62A
PEAK : 6.16A
Width : 200mil

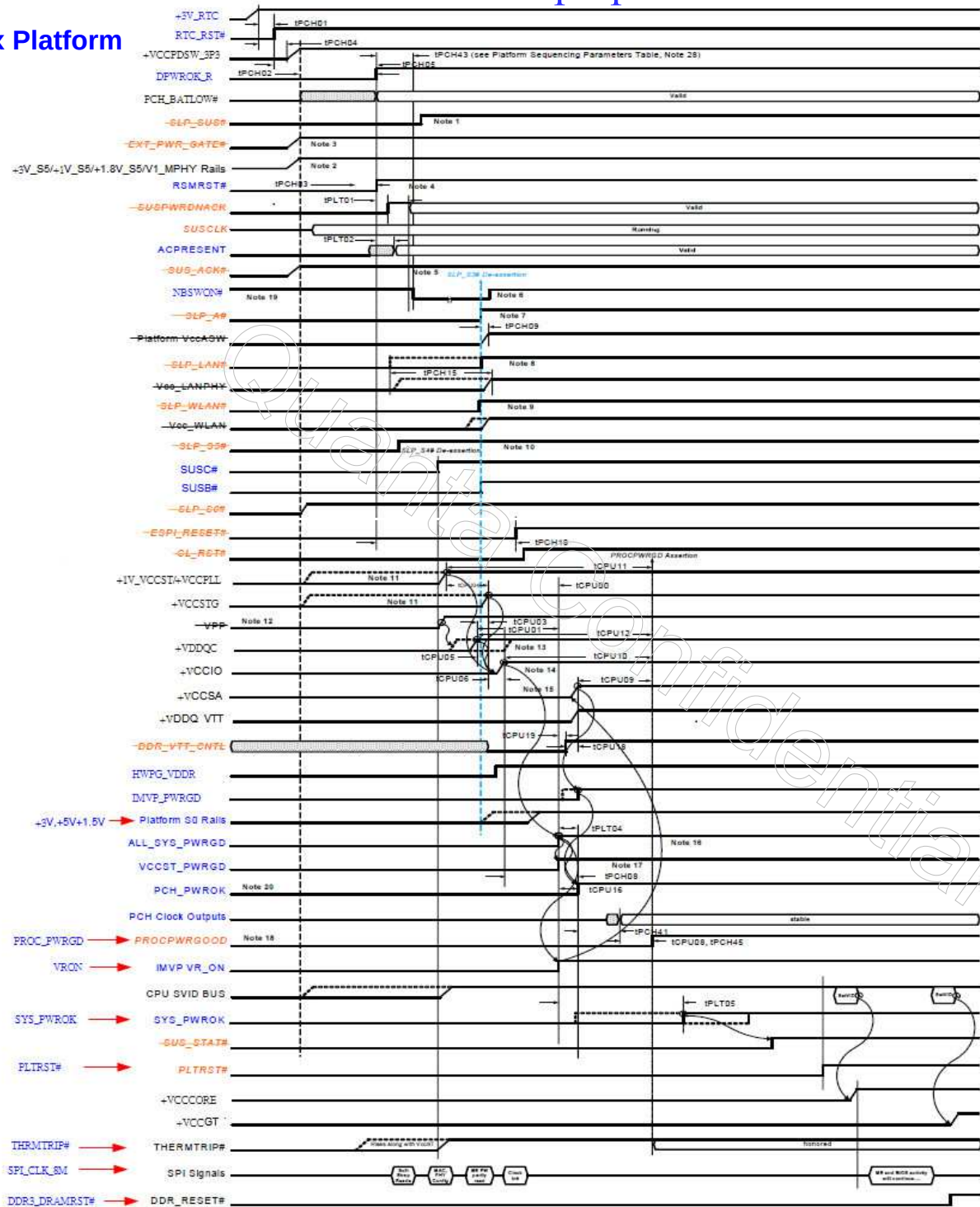
 Quanta Computer Inc. PROJECT : ZRW			
Size	Document Number	Rev	
	GPU PWR CRL	3A	
Date:	Monday, July 20, 2015	Sheet	43 of 48

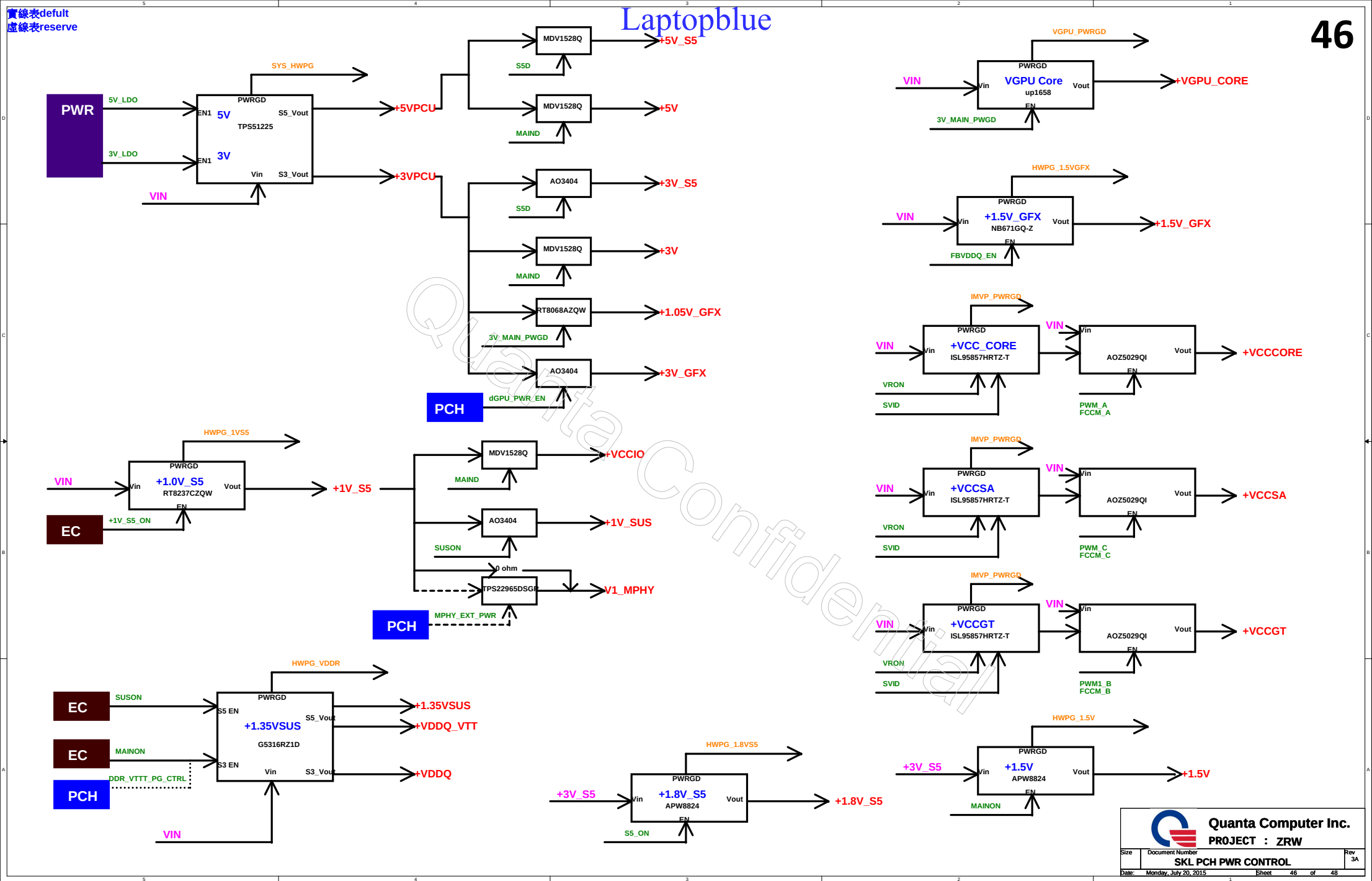
Battery Mode

Non Deep Sx

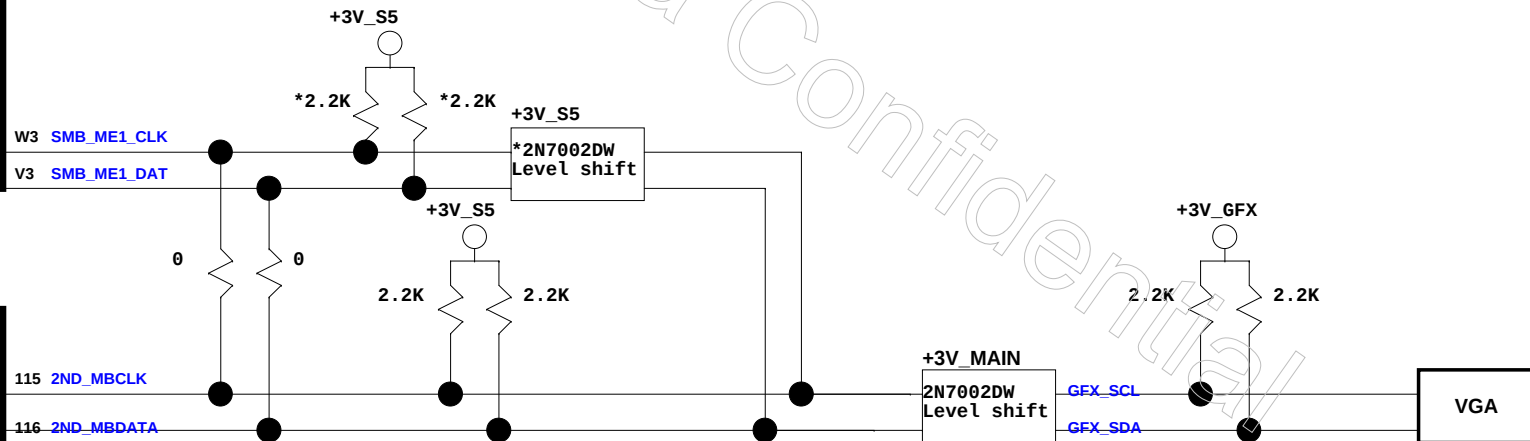
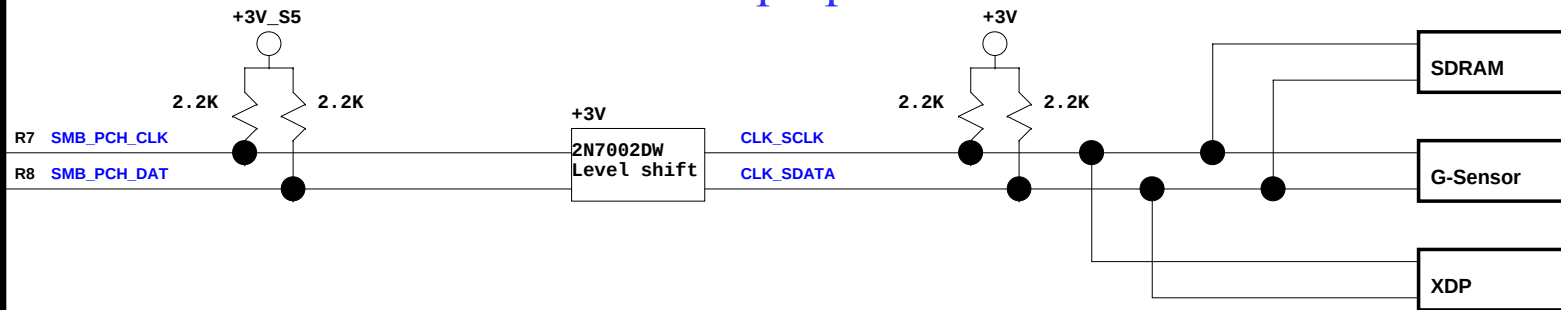
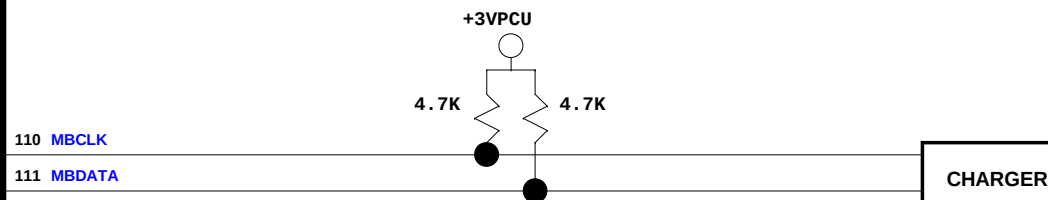
Laptopblue



Skylake U Non-Deep Sx Platform
Power on sequence



Skylake U

EC
IT8987CX

Model	Date	CHANGE LIST
ZRW REV:A	1/20	1. FIRST RELEASED
ZRW REV:B	2/4	1. PU3#3 enable pin from VGPU_EN change to 3V_MAIN_PWGD control , add PR343 0ohm. (page 41) 2. U35#U11 #U12 connect to +1.8V_S5 for support Cannonlake-U PCH. (page 10) 3. U46#3 from net USB_OC1# change connect to USB_OC2# PCH. (page 28) 4. Add R776 33 0hm and C805 180 pf in NBSWON#. (page 27) 5. Change LAN_WAKE# pin from CPU_LAN_WAKE# to WAKE#(ball BB15) to support CPPM(PCIE LTR&OBFF&L1 off) (page 08) 6. add PR344 between PU14#12 & JP13. for GT3 CPU (page 33) 7. add PR345 between PU13#12 & JP12 for GT3 CPU (page 34)
	2/12	1. net ACCEL_INTA from U35#AD1 change to U35#AB1 [UART0_RX] net TP_INT_PCH from U35#AD2 change to U35#AB3 [UART0_CTS#] (page 04) 2. CN3 all pin from UART1 change connect to UART2 (page 04) 3. R587 from 0 ohm change to 1k pull down for USB2_ID (page 06) 4. add C806 for EMI request R748 0 ohm no stuff from EC site move at CPU site (page 07) 5. R293 stuff 4.7k , R294 from 4.99k change to 5.49k (page22) 6. XDP_TCK0,XDP_TCK1,XDP_TMS,XDP_TDI don't need pull up or pull down NO Stuff R515 , R558, R514, R537. (page 02)
	2/12	1. p.40 PR153 from 22 ohm change to 220 ohm for S3/S4/S5 bo bo sound issue.
	3/4	1. p.15 & p.16 L1 & L2 footprint from 0603 change to 0402 2. p.6 Delete UART1 4 pcs TP 3. p.25 EMI request add C807 33p for CLKRUN# 4. p.31 +3vpcu & +5vpcu from MPS NB679 change to TPS51225 5. p.24 R420 & R422 vendor suggest from 56 ohm change to 62 ohm [CS06202JB15]
ZRW REV:C1	4/30	1. p.2 Stuff 10k ohm_4 of R780 & R781. [KBSMI# & EC_SC1#] Pull up to +3V. 2. P.29 U45 EC pin 70 connect to p.30 PU5#8 IDCHG net 3. P.29 U45 EC pin 95 connect to net IOAC_LANPWR# 4. P.06 Add PQ6059 & PQ6060 for EC_RTCRST control reset RTC_SRTC_RST# & RTC_RST#
	5/7	1. p.09 removed MPHY_EXT_PWR control power function. [Removed U11, R195, R197,C208,C253] 2. p.07 R576 & R572 from value 4.7k change to 2.2k
ZRW REV:C2	5/8	1. p.36 & p37 change new PU6,PU7,PU8,PU9 footprint AOZ5029Q1-5 & partnumber AL005029001 2. p.28 Delete L8,L9,L10,L14,L15,17 EMI Choke footprint
	5/25	1. p.09 R762 [LPM_ZVM_N] & R763 [MSM#] No Stuff for GT3 2. p.09 add R789 0 ohm for VCCHDA p.24 R365 stuff 0 ohm connect to +3V , R363 0 ohm no stuff connect to +1.5v 3. p.34 delete +VCCEOPIO circuit 4. p.05 delete R141 , R133 , R547 for SVID data,Alert#,clk 5. p.39 delete VCCGT circuit 6. p.37 delete PR77 & PR88 for VCCGT connect to VCCGT
	5/28	1. p.03 Delete R656 & R189. DDR0_ALERT# & DDR1_ALERT# connect to GND 2. p.09 Delete R763 0 ohm for net MSM#.
ZRW REV:C3	6/18	1. p.05 Add C814 1000p/50v_4 connect +1V_VCCST and near R138 SVID. 2. p.36 Add PC6228 1000p/50v_4 connect +1V_VCCST and near RR341 SVID. 3. p.02 Add R795 , R796 , R797 0ohm for DCI USB 3.0 test fixture 4. p.11 delete XDP function connector U27 , U30 , CN1 5. p.09 Remove short Jumper for all +1V_S5. 1. R163 , R159 ,R581, R146 ,R149 , R157 , R173 , R151 , R170 , R136 2. R545 , R144 , R150 , R147 , R551 , R557, R584 [VCCCLK1-6] 3. R168 [+1_S5 -> V1_MPHY] 6. p.36 remove PR37 Shortpad for SVID_ALERT# 7. p.07 Delete Q33 , R579 ,R583 for SMBus(EC)
	6/23	1. p.02 Delete TP82 and Net [SKTOCC#] 2. p.05 reserve 5 pcs 1000 pF capacitor in +1V_VCCST [C815,C816,C817,C818,C819] , no stuff by default 3. p.09 Reserve test point TP95 for CPU AK13 ball 4. p.32 add PC6230 22u/6.3v_6 in connect to PQ23.1 [+1V_SUS]